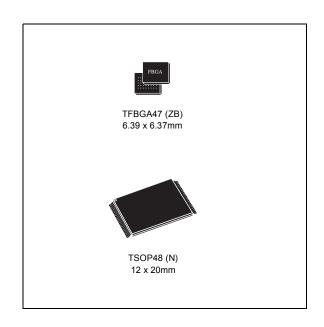


M28W320FCT M28W320FCB

32 Mbit (2Mb x16, Boot Block) 3V Supply Flash Memory

Features

- Supply Voltage
 - V_{DD} = 2.7V to 3.6V Core Power Supply
 - V_{DDQ}= 1.65V to 3.6V for Input/Output
 - V_{PP} = 12V for fast Program (optional)
- Access Time: 70, 80, 90, 100ns
- Programming Time
 - 10µs typical
 - Double Word Programming Option
 - Quadruple Word Programming Option
- Common Flash Interface
- Memory Blocks
 - Parameter Blocks (Top or Bottom location)
 - Main Blocks
- Block Locking
 - All blocks locked at Power Up
 - Any combination of blocks can be locked
 - WP for Block Lock-Down
- Security
 - 128 bit user Programmable OTP cells
 - 64 bit unique device identifier
- Automatic Stand-by mode
- Program and Erase Suspend
- 100,000 Program/Erase cycles per block
- Electronic Signature
 - Manufacturer Code: 20h
 - Top Device Code, M28W320FCT: 88BAh
 - Bottom Device Code, M28W320FCB: 88BBh
- RoHS compliant packages



November 2008 208010-05 1/69

Contents

1	Sum	mary description
2	Sign	al descriptions 12
	2.1	Address inputs (A0-A20)
	2.2	Data input/output (DQ0-DQ15)
	2.3	Chip Enable (E)
	2.4	Output Enable (G)
	2.5	Write Enable (W)
	2.6	Write Protect (WP)
	2.7	Reset (RP)
	2.8	V _{DD} supply voltage
	2.9	V _{DDQ} supply voltage
	2.10	V _{PP} Program supply voltage
	2.11	V _{SS} ground
3	Bus	operations14
	3.1	Read
	3.2	Write
	3.3	Output Disable
	3.4	Standby
	3.5	Automatic Standby
	3.6	Reset
4	Com	mand interface
	4.1	Read Memory Array command
	4.2	Read Status Register command
	4.3	Read Electronic Signature command
	4.4	Read CFI Query command
	4.5	Block Erase command
	4.6	Program command
	4.7	Double Word Program command
	4.8	Quadruple Word Program command
2/69		Numonyx

	4.9	Clear Status Register command	19
	4.10	Program/Erase Suspend command	20
	4.11	Program/Erase Resume command	20
	4.12	Protection Register Program command	20
	4.13	Block Lock command	21
	4.14	Block Unlock command	21
	4.15	Block Lock-Down command	21
5	Block	locking	25
	5.1	Reading a Block's Lock Status	25
	5.2	Locked state	25
	5.3	Unlocked state	25
	5.4	Lock-Down state	26
	5.5	Locking operations during Erase Suspend	26
6	Status	s Register	28
	6.1	Program/Erase Controller Status (Bit 7)	28
	6.2	Erase Suspend Status (Bit 6)	28
	6.3	Erase Status (Bit 5)	29
	6.4	Program Status (Bit 4)	29
	6.5	V _{PP} Status (Bit 3)	29
	6.6	Program Suspend Status (Bit 2)	29
	6.7	Block Protection Status (Bit 1)	30
	6.8	Reserved (Bit 0)	30
7	Maxin	num rating	31
8	DC an	nd AC parameters	32
9	Packa	nge mechanical	41
10	Part n	numbering	44
A			
Appendix	A BI	ock address tables	46
Appendix	ВС	ommon Flash Interface (CFI)	51
Numonyx	<u> </u>	3	/69

Appendix C	Flowcharts and pseudo codes	56
Appendix D	Command interface and Program/Erase Controller state	64
11 Re	vision history	68

Numonyx

List of tables

Table 1.	Signal Names	8
Table 2.	Bus Operations	. 15
Table 3.	Command Codes	. 17
Table 4.	Commands	. 22
Table 5.	Read Electronic Signature	. 23
Table 6.	Read Block Lock Signature	
Table 7.	Read Protection Register and Lock Register	. 23
Table 8.	Program, Erase Times and Program/Erase Endurance Cycles	. 24
Table 9.	Block Lock Status	. 26
Table 10.	Protection Status	. 27
Table 11.	Status Register Bits	
Table 12.	Absolute Maximum Ratings	
Table 13.	Operating and AC Measurement Conditions	
Table 14.	Capacitance	
Table 15.	DC Characteristics	. 33
Table 16.	Read AC Characteristics	
Table 17.	Write AC Characteristics, Write Enable Controlled	
Table 18.	Write AC Characteristics, Chip Enable Controlled	
Table 19.	Power-Up and Reset AC Characteristics	
Table 20.	TSOP48 - 48 lead Plastic Thin Small Outline, 12 x 20mm, Package Mechanical Data	
Table 21.	TFBGA47 6.39x6.37mm - 8x6 ball array, 0.75mm pitch, Package Mechanical Data	. 42
Table 22.	Ordering Information Scheme	
Table 23.	Daisy Chain Ordering Scheme	
Table 24.	Top Boot Block Addresses, M28W320FCT	
Table 25.	Bottom Boot Block Addresses, M28W320FCB	
Table 26.	Query Structure Overview	
Table 27.	CFI Query Identification String	
Table 28.	CFI Query System Interface Information	
Table 29.	Device Geometry Definition	
Table 30.	Primary Algorithm-Specific Extended Query Table	
Table 31.	Security Code Area	
Table 32.	Write State Machine Current/Next, sheet 1 of 2	
Table 33.	Write State Machine Current/Next, sheet 2 of 2	. 66
Table 34.	Document revision history	. 68

List of figures

Figure 1.	Logic Diagram	. 8
Figure 2.	TSOP Connections	
Figure 3.	TFBGA Connections (Top view through package)	10
Figure 4.	Block Addresses	
Figure 5.	Protection Register Memory Map	11
Figure 6.	AC Measurement I/O Waveform	
Figure 7.	AC Measurement Load Circuit	33
Figure 8.	Read AC Waveforms	35
Figure 9.	Write AC Waveforms, Write Enable Controlled	36
Figure 10.	Write AC Waveforms, Chip Enable Controlled	38
Figure 11.	Power-Up and Reset AC Waveforms	40
Figure 12.	TSOP48 - 48 lead Plastic Thin Small Outline, 12 x 20mm, Package Outline	41
Figure 13.	TFBGA47 6.39x6.37mm - 8x6 ball array, 0.75mm pitch, Bottom View Package Outline	42
Figure 14.	TFBGA47 Daisy Chain - Package Connections (Top view through package)	
Figure 15.	TFBGA47 Daisy Chain - PCB Connections proposal (Top view through package)	
Figure 16.	Program Flowchart and Pseudo Code	
Figure 17.	Double Word Program Flowchart and Pseudo Code	
Figure 18.	Quadruple Word Program Flowchart and Pseudo Code	58
Figure 19.	Program Suspend & Resume Flowchart and Pseudo Code	
Figure 20.	Erase Flowchart and Pseudo Code	60
Figure 21.	Erase Suspend & Resume Flowchart and Pseudo Code	
Figure 22.	Locking Operations Flowchart and Pseudo Code	
Figure 23.	Protection Register Program Flowchart and Pseudo Code	63

1 Summary description

The M28W320FCT and M28W320FCB are 32 Mbit (2 Mbit x 16) non-volatile Flash memories that can be erased electrically at the block level and programmed in-system on a Word-by-Word basis. These operations can be performed using a single low voltage (2.7 to 3.6V) supply. V_{DDQ} allows to drive the I/O pin down to 1.65V. An optional 12V V_{PP} power supply is provided to speed up customer programming.

The devices feature an asymmetrical blocked architecture. They have an array of 71 blocks: 8 Parameter Blocks of 4 KWord and 63 Main Blocks of 32 KWord. M28W320FCT has the Parameter Blocks at the top of the memory address space while the M28W320FCB locates the Parameter Blocks starting from the bottom. The memory maps are shown in *Figure 4: Block Addresses*.

Both devices feature an instant, individual block locking scheme that allows any block to be locked or unlocked with no latency, enabling instant code and data protection. All blocks have three levels of protection. They can be locked and locked-down individually preventing any accidental programming or erasure. There is an additional hardware protection against program and erase. When $V_{PP} \leq V_{PPLK}$ all blocks are protected against program or erase. All blocks are locked at Power Up.

Each block can be erased separately. Erase can be suspended in order to perform either read or program in any other block and then resumed. Program can be suspended to read data in any other block and then resumed. Each block can be programmed and erased over 100,000 cycles.

The device includes a Protection Register to increase the protection of a system design. The Protection Register is divided into two segments, the first is a 64 bit area which contains a unique device number written by Numonyx, while the second is a 128 bit area, one-time-programmable by the user. The user programmable segment can be permanently protected. *Figure 5*, shows the Protection Register Memory Map.

Program and Erase commands are written to the Command Interface of the memory. An onchip Program/Erase Controller takes care of the timings necessary for program and erase operations. The end of a program or erase operation can be detected and any error conditions identified. The command set required to control the memory is consistent with JEDEC standards.

The memory is offered in TSOP48 (10 X 20mm) and TFBGA47 (6.39 x 6.37mm, 0.75mm pitch) packages and is supplied with all the bits erased (set to '1').

In order to meet environmental requirements, Numonyx offers the M28W320FCT and M28W320FCB in RoHS compliant packages. RoHS compliant packages are Lead-free. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label.

Figure 1. Logic Diagram

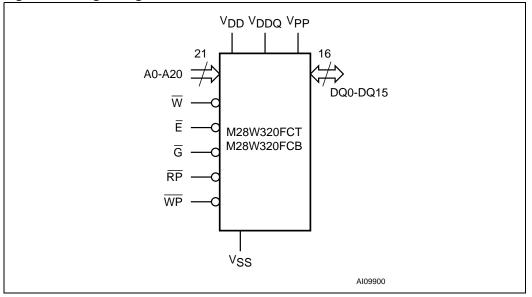
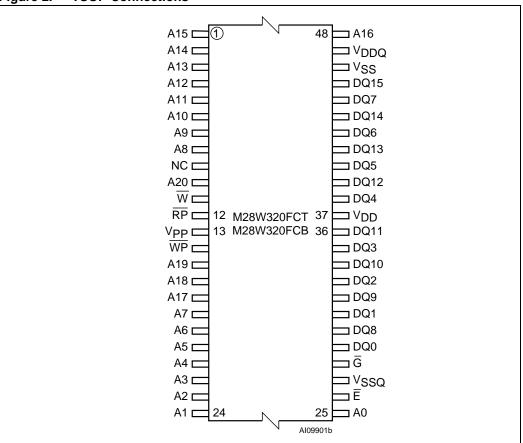
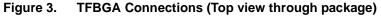


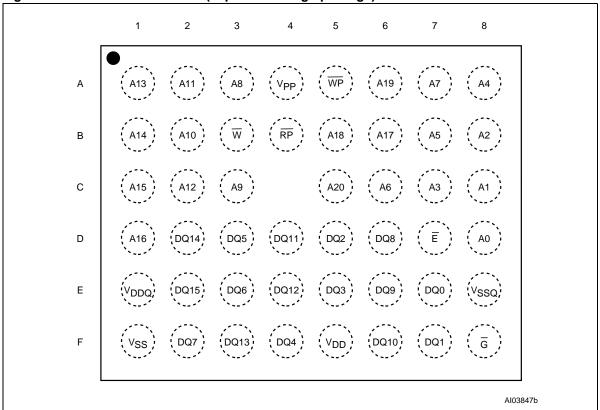
Table 1. Signal Names

A0-A20	Address Inputs
DQ0-DQ15	Data Input/Output
Ē	Chip Enable
G	Output Enable
W	Write Enable
RP	Reset
WP	Write Protect
V _{DD}	Core Power Supply
V_{DDQ}	Power Supply for Input/Output
V _{PP}	Optional Supply Voltage for Fast Program & Erase
V _{SS}	Ground
NC	Not Connected Internally





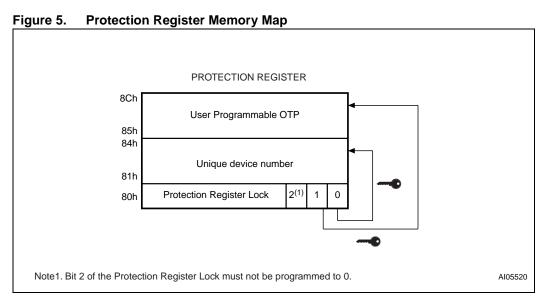




M28W320FCT M28W320FCB Top Boot Block Addresses Bottom Boot Block Addresses 1FFFFF 1FFFFF 4 KWords 32 KWords 1FF000 1F8000 1F7FFF 32 KWords Total of 8 1F0000 4 KWord Blocks Total of 63 1F8FFF 32 KWord Blo 4 KWords 32 KWords 1F0000 00FFFF 32 KWords 008000 007FFF 4 KWords Total of 63 007000 32 KWord Blocks Total of 8 00FFFF 4 KWord Block 32 KWords 000FFF 32 KWords 4 KWords 000000 000000 AI09902

Figure 4. Block Addresses

1. Also see *Appendix A*, *Table 24* and *Table 25* for a full listing of the Block Addresses.



2 Signal descriptions

See Figure 1: Logic Diagram and Table 1: Signal Names, for a brief overview of the signals connected to this device.

2.1 Address inputs (A0-A20)

The Address Inputs select the cells in the memory array to access during Bus Read operations. During Bus Write operations they control the commands sent to the Command Interface of the internal state machine.

2.2 Data input/output (DQ0-DQ15)

The Data I/O outputs the data stored at the selected address during a Bus Read operation or inputs a command or the data to be programmed during a Write Bus operation.

2.3 Chip Enable (\overline{E})

The Chip Enable input activates the memory control logic, input buffers, decoders and sense amplifiers. When Chip Enable is at V_{IL} and Reset is at V_{IH} the device is in active mode. When Chip Enable is at V_{IH} the memory is deselected, the outputs are high impedance and the power consumption is reduced to the stand-by level.

2.4 Output Enable (G)

The Output Enable controls data outputs during the Bus Read operation of the memory.

2.5 Write Enable (\overline{W})

The Write Enable controls the Bus Write operation of the memory's Command Interface. The data and address inputs are latched on the rising edge of Chip Enable, E, or Write Enable, W, whichever occurs first.

2.6 Write Protect (WP)

Write Protect is an input that gives an additional hardware protection for each block. When Write Protect is at V_{IL} , the Lock-Down is enabled and the protection status of the block cannot be changed. When Write Protect is at V_{IH} , the Lock-Down is disabled and the block can be locked or unlocked. (refer to *Table 7: Read Protection Register and Lock Register*).

2.7 Reset (RP)

The Reset input provides a hardware reset of the memory. When Reset is at V_{IL} , the memory is in reset mode: the outputs are high impedance and the current consumption is minimized. After Reset all blocks are in the Locked state. When Reset is at V_{IH} , the device is in normal operation. Exiting reset mode the device enters read array mode, but a negative transition of Chip Enable or a change of the address is required to ensure valid data outputs.

2.8 V_{DD} supply voltage

 V_{DD} provides the power supply to the internal core of the memory device. It is the main power supply for all operations (Read, Program and Erase).

2.9 V_{DDQ} supply voltage

 V_{DDQ} provides the power supply to the I/O pins and enables all Outputs to be powered independently from V_{DD} . V_{DDQ} can be tied to V_{DD} or can use a separate supply.

2.10 V_{PP} Program supply voltage

 V_{PP} is both a control input and a power supply pin. The two functions are selected by the voltage range applied to the pin. The Supply Voltage V_{DD} and the Program Supply Voltage V_{PP} can be applied in any order.

If V_{PP} is kept in a low voltage range (0V to 3.6V) V_{PP} is seen as a control input. In this case a voltage lower than V_{PPLK} gives an absolute protection against program or erase, while $V_{PP} > V_{PP1}$ enables these functions (see *Table 15: DC Characteristics*). V_{PP} is only sampled at the beginning of a Program or Erase; a change in its value after the operation has started does not have any effect on Program or Erase, however for Double or Quadruple Word Program the results are uncertain.

If V_{PP} is in the range 11.4V to 12.6V it acts as a power supply pin. In this condition V_{PP} must be stable until the Program/Erase algorithm is completed (see *Table 17* and *Table 18*).

2.11 V_{SS} ground

V_{SS} is the reference for all voltage measurements.

Note: Each device in a system should have V_{DD} , V_{DDQ} and V_{PP} decoupled with a 0.1 μ F capacitor close to the pin. See *Figure 7: AC Measurement Load Circuit*. The PCB trace widths should be sufficient to carry the required V_{PP} program and erase currents.

3 Bus operations

There are six standard bus operations that control the device. These are Bus Read, Bus Write, Output Disable, Standby, Automatic Standby and Reset. See *Table 2: Bus Operations*, for a summary.

Typically glitches of less than 5ns on Chip Enable or Write Enable are ignored by the memory and do not affect bus operations.

3.1 Read

Read Bus operations are used to output the contents of the Memory Array, the Electronic Signature, the Status Register and the Common Flash Interface. Both Chip Enable and Output Enable must be at V_{IL} in order to perform a read operation. The Chip Enable input should be used to enable the device. Output Enable should be used to gate data onto the output. The data read depends on the previous command written to the memory (see Command Interface section). See *Figure 8: Read AC Waveforms*, and *Table 16: Read AC Characteristics*, for details of when the output becomes valid.

Read mode is the default state of the device when exiting Reset or after power-up.

3.2 Write

Bus Write operations write Commands to the memory or latch Input Data to be programmed. A write operation is initiated when Chip Enable and Write Enable are at V_{IL} with Output Enable at V_{IH} . Commands, Input Data and Addresses are latched on the rising edge of Write Enable or Chip Enable, whichever occurs first.

See *Figure 9* and *Figure 10*, Write AC Waveforms, and *Table 17* and *Table 18*, Write AC Characteristics, for details of the timing requirements.

3.3 Output Disable

The data outputs are high impedance when the Output Enable is at V_{IH}.

3.4 Standby

Standby disables most of the internal circuitry allowing a substantial reduction of the current consumption. The memory is in stand-by when Chip Enable is at V_{IH} and the device is in read mode. The power consumption is reduced to the stand-by level and the outputs are set to high impedance, independently from the Output Enable or Write Enable inputs. If Chip Enable switches to V_{IH} during a program or erase operation, the device enters Standby mode when finished.

3.5 Automatic Standby

Automatic Standby provides a low power consumption state during Read mode. Following a read operation, the device enters Automatic Standby after 150ns of bus inactivity even if Chip Enable is Low, $V_{\rm IL}$, and the supply current is reduced to $I_{\rm DD1}$. The data Inputs/Outputs will still output data if a bus Read operation is in progress.

3.6 Reset

During Reset mode when Output Enable is Low, V_{IL} , the memory is deselected and the outputs are high impedance. The memory is in Reset mode when Reset is at V_{IL} . The power consumption is reduced to the Standby level, independently from the Chip Enable, Output Enable or Write Enable inputs. If Reset is pulled to V_{SS} during a Program or Erase, this operation is aborted and the memory content is no longer valid.

Table 2. Bus Operations⁽¹⁾

Operation	Ē	G	w	RP	WP	V _{PP}	DQ0-DQ15
Bus Read	V_{IL}	V_{IL}	V_{IH}	V _{IH}	Х	Don't Care	Data Output
Bus Write	V _{IL}	V _{IH}	V _{IL}	V _{IH}	Х	V _{DD} or V _{PPH}	Data Input
Output Disable	V _{IL}	V _{IH}	V _{IH}	V _{IH}	Х	Don't Care	Hi-Z
Standby	V _{IH}	Х	Х	V _{IH}	Х	Don't Care	Hi-Z
Reset	Х	Х	Х	V _{IL}	Х	Don't Care	Hi-Z

^{1.} $X = V_{IL}$ or V_{IH} , $V_{PPH} = 12V \pm 5\%$.

4 Command interface

All Bus Write operations to the memory are interpreted by the Command Interface. Commands consist of one or more sequential Bus Write operations. An internal Program/Erase Controller handles all timings and verifies the correct execution of the Program and Erase commands. The Program/Erase Controller provides a Status Register whose output may be read at any time during, to monitor the progress of the operation, or the Program/Erase states. See *Table 3: Command Codes*, for a summary of the commands and see *Appendix D*, and *Table 32*, Write State Machine Current/Next, for a summary of the Command Interface.

The Command Interface is reset to Read mode when power is first applied, when exiting from Reset or whenever V_{DD} is lower than V_{LKO} . Command sequences must be followed exactly. Any invalid combination of commands will reset the device to Read mode. Refer to *Table 4: Commands*, in conjunction with the text descriptions below.

4.1 Read Memory Array command

The Read command returns the memory to its Read mode. One Bus Write cycle is required to issue the Read Memory Array command and return the memory to Read mode. Subsequent read operations will read the addressed location and output the data. When a device Reset occurs, the memory defaults to Read mode.

4.2 Read Status Register command

The Status Register indicates when a program or erase operation is complete and the success or failure of the operation itself. Issue a Read Status Register command to read the Status Register's contents. Subsequent Bus Read operations read the Status Register at any address, until another command is issued. See *Table 11: Status Register Bits*, for details on the definitions of the bits.

The Read Status Register command may be issued at any time, even during a Program/Erase operation. Any Read attempt during a Program/Erase operation will automatically output the content of the Status Register.

4.3 Read Electronic Signature command

The Read Electronic Signature command reads the Manufacturer and Device Codes and the Block Locking Status, or the Protection Register.

The Read Electronic Signature command consists of one write cycle, a subsequent read will output the Manufacturer Code, the Device Code, the Block Lock and Lock-Down Status, or the Protection and Lock Register. See *Table 5*, *Table 6* and *Table 7* for the valid address.

Table 3. Command Codes

Hex Code	Command
01h	Block Lock confirm
10h	Program
20h	Erase
2Fh	Block Lock-Down confirm
30h	Double Word Program
40h	Program
50h	Clear Status Register
55h	Reserved
56h	Quadruple Word Program
60h	Block Lock, Block Unlock, Block Lock-Down
70h	Read Status Register
90h	Read Electronic Signature
98h	Read CFI Query
B0h	Program/Erase Suspend
C0h	Protection Register Program
D0h	Program/Erase Resume, Block Unlock confirm
FFh	Read Memory Array

4.4 Read CFI Query command

The Read Query Command is used to read data from the Common Flash Interface (CFI) Memory Area, allowing programming equipment or applications to automatically match their interface to the characteristics of the device. One Bus Write cycle is required to issue the Read Query Command. Once the command is issued subsequent Bus Read operations read from the Common Flash Interface Memory Area. See *Appendix B: Common Flash Interface (CFI)*, *Table 26*, *Table 27*, *Table 28*, *Table 29*, *Table 30* and *Table 31* for details on the information contained in the Common Flash Interface memory area.

4.5 Block Erase command

The Block Erase command can be used to erase a block. It sets all the bits within the selected block to '1'. All previous data in the block is lost. If the block is protected then the Erase operation will abort, the data in the block will not be changed and the Status Register will output the error.

Two Bus Write cycles are required to issue the command.

- The first bus cycle sets up the Erase command.
- 2. The second latches the block address in the internal state machine and starts the Program/Erase Controller.

If the second bus cycle is not Write Erase Confirm (D0h), Status Register bits b4 and b5 are set and the command aborts.

Erase aborts if Reset turns to V_{IL} . As data integrity cannot be guaranteed when the Erase operation is aborted, the block must be erased again.

During Erase operations the memory will accept the Read Status Register command and the Program/Erase Suspend command, all other commands will be ignored. Typical Erase times are given in *Table 8: Program, Erase Times and Program/Erase Endurance Cycles*.

See *Appendix C*, *Figure 20: Erase Flowchart and Pseudo Code*, for a suggested flowchart for using the Erase command.

4.6 Program command

The memory array can be programmed word-by-word. Two bus write cycles are required to issue the Program Command.

- 1. The first bus cycle sets up the Program command.
- 2. The second latches the Address and the Data to be written and starts the Program/Erase Controller.

During Program operations the memory will accept the Read Status Register command and the Program/Erase Suspend command. Typical Program times are given in *Table 8:*Program, Erase Times and Program/Erase Endurance Cycles.

Programming aborts if Reset goes to V_{IL} . As data integrity cannot be guaranteed when the program operation is aborted, the block containing the memory location must be erased and reprogrammed.

See *Appendix C*, *Figure 16: Program Flowchart and Pseudo Code*, for the flowchart for using the Program command.

4.7 Double Word Program command

This feature is offered to improve the programming throughput, writing a page of two adjacent words in parallel. The two words must differ only for the address A0. Programming should not be attempted when V_{PP} is not at V_{PPH} .

Three bus write cycles are necessary to issue the Double Word Program command.

- 1. The first bus cycle sets up the Double Word Program Command.
- 2. The second bus cycle latches the Address and the Data of the first word to be written.
- 3. The third bus cycle latches the Address and the Data of the second word to be written and starts the Program/Erase Controller.

Read operations output the Status Register content after the programming has started. Programming aborts if Reset goes to V_{IL} . As data integrity cannot be guaranteed when the program operation is aborted, the block containing the memory location must be erased and reprogrammed.

See *Appendix C*, *Figure 17: Double Word Program Flowchart and Pseudo Code*, for the flowchart for using the Double Word Program command.

4.8 Quadruple Word Program command

This feature is offered to improve the programming throughput, writing a page of four adjacent words in parallel. The four words must differ only for the addresses A0 and A1. Programming should not be attempted when V_{PP} is not at V_{PPH} .

Five bus write cycles are necessary to issue the Quadruple Word Program command.

- 1. The first bus cycle sets up the Quadruple Word Program Command.
- 2. The second bus cycle latches the Address and the Data of the first word to be written.
- 3. The third bus cycle latches the Address and the Data of the second word to be written.
- 4. The fourth bus cycle latches the Address and the Data of the third word to be written.
- 5. The fifth bus cycle latches the Address and the Data of the fourth word to be written and starts the Program/Erase Controller.

Read operations output the Status Register content after the programming has started. Programming aborts if Reset goes to V_{IL} . As data integrity cannot be guaranteed when the program operation is aborted, the block containing the memory location must be erased and reprogrammed.

See Appendix C, Figure 18: Quadruple Word Program Flowchart and Pseudo Code, for the flowchart for using the Quadruple Word Program command.

4.9 Clear Status Register command

The Clear Status Register command can be used to reset bits 1, 3, 4 and 5 in the Status Register to '0'. One bus write cycle is required to issue the Clear Status Register command.

The bits in the Status Register do not automatically return to '0' when a new Program or Erase command is issued. The error bits in the Status Register should be cleared before attempting a new Program or Erase command.

4.10 Program/Erase Suspend command

The Program/Erase Suspend command is used to pause a Program or Erase operation. One bus write cycle is required to issue the Program/Erase command and pause the Program/Erase controller.

During Program/Erase Suspend the Command Interface will accept the Program/Erase Resume, Read Array, Read Status Register, Read Electronic Signature and Read CFI Query commands. Additionally, if the suspend operation was Erase then the Program, Double Word Program, Quadruple Word Program, Block Lock, Block Lock-Down or Protection Program commands will also be accepted. The block being erased may be protected by issuing the Block Protect, Block Lock or Protection Program commands. When the Program/Erase Resume command is issued the operation will complete. Only the blocks not being erased may be read or programmed correctly.

During a Program/Erase Suspend, the device can be placed in a pseudo-standby mode by taking Chip Enable to V_{IH} . Program/Erase is aborted if Reset turns to V_{IL} .

See Appendix C, Figure 19: Program Suspend & Resume Flowchart and Pseudo Code, and Figure 21: Erase Suspend & Resume Flowchart and Pseudo Code for flowcharts for using the Program/Erase Suspend command.

4.11 Program/Erase Resume command

The Program/Erase Resume command can be used to restart the Program/Erase Controller after a Program/Erase Suspend operation has paused it. One Bus Write cycle is required to issue the command. Once the command is issued subsequent Bus Read operations read the Status Register.

See Appendix C, Figure 19: Program Suspend & Resume Flowchart and Pseudo Code, and Figure 21: Erase Suspend & Resume Flowchart and Pseudo Code, and Figure 21: Erase Suspend & Resume Flowchart and Pseudo Code for flowcharts for using the Program/Erase Resume command.

4.12 Protection Register Program command

The Protection Register Program command is used to Program the 128 bit user One-Time-Programmable (OTP) segment of the Protection Register. The segment is programmed 16 bits at a time. When shipped all bits in the segment are set to '1'. The user can only program the bits to '0'.

Two write cycles are required to issue the Protection Register Program command.

- 1. The first bus cycle sets up the Protection Register Program command.
- 2. The second latches the Address and the Data to be written to the Protection Register and starts the Program/Erase Controller.

Read operations output the Status Register content after the programming has started.

The segment can be protected by programming bit 1 of the Protection Lock Register (see *Figure 5: Protection Register Memory Map*). Attempting to program a previously protected Protection Register will result in a Status Register error. The protection of the Protection Register is not reversible.

The Protection Register Program cannot be suspended.

4.13 Block Lock command

The Block Lock command is used to lock a block and prevent Program or Erase operations from changing the data in it. All blocks are locked at power-up or reset.

Two Bus Write cycles are required to issue the Block Lock command.

- The first bus cycle sets up the Block Lock command.
- 2. The second Bus Write cycle latches the block address.

The lock status can be monitored for each block using the Read Electronic Signature command. *Table 10* shows the protection status after issuing a Block Lock command.

The Block Lock bits are volatile, once set they remain set until a hardware reset or power-down/power-up. They are cleared by a Blocks Unlock command. Refer to the section, Block Locking, for a detailed explanation.

4.14 Block Unlock command

The Block Unlock command is used to unlock a block, allowing the block to be programmed or erased. Two Bus Write cycles are required to issue the Block Unlock command.

- 1. The first bus cycle sets up the Block Unlock command.
- 2. The second Bus Write cycle latches the block address.

The lock status can be monitored for each block using the Read Electronic Signature command. *Table 10* shows the protection status after issuing a Block Unlock command. Refer to the section, Block Locking, for a detailed explanation.

4.15 Block Lock-Down command

A locked block cannot be Programmed or Erased, or have its protection status changed when \overline{WP} is low, V_{IL} . When \overline{WP} is high, V_{IH_1} the Lock-Down function is disabled and the locked blocks can be individually unlocked by the Block Unlock command.

Two Bus Write cycles are required to issue the Block Lock-Down command.

- 1. The first bus cycle sets up the Block Lock command.
- 2. The second Bus Write cycle latches the block address.

The lock status can be monitored for each block using the Read Electronic Signature command. Locked-Down blocks revert to the locked (and not locked-down) state when the device is reset on power-down. *Table 10* shows the protection status after issuing a Block Lock-Down command. Refer to the section, Block Locking, for a detailed explanation.

Table 4. Commands⁽¹⁾⁽²⁾

			Bus Write Operations													
Commands	Cycles	1st Cycle			2nd Cycle			3rd Cycle			4th Cycle			5th Cycle		
	0	Ор	Add	Data	Ор	Add	Data	Ор	Add	Data	Ор	Add	Data	Ор	Add	Data
Read Memory Array	1+	Write	Х	FFh	Read	RA	RD									
Read Status Register	1+	Write	Х	70h	Read	Х	SRD									
Read Electronic Signature	1+	Write	Х	90h	Read	SA (3)	IDh									
Read CFI Query	1+	Write	Х	98h	Read	QA	QD									
Erase	2	Write	Х	20h	Write	ВА	D0h									
Program	2	Write	Х	40h or 10h	Write	PA	PD									
Double Word Program ⁽⁴⁾	3	Write	Х	30h	Write	PA1	PD1	Write	PA2	PD2						
Quadruple Word Program ⁽⁵⁾	5	Write	Х	56h (6)	Write	PA1	PD1	Write	PA2	PD2	Write	PA3	PD3	Write	PA4	PD4
Clear Status Register	1	Write	Х	50h												
Program/Erase Suspend	1	Write	Х	B0h												
Program/Erase Resume	1	Write	Х	D0h												
Block Lock	2	Write	Х	60h	Write	ВА	01h									
Block Unlock	2	Write	Х	60h	Write	ВА	D0h									
Block Lock-Down	2	Write	Х	60h	Write	ВА	2Fh									
Protection Register Program	2	Write	Х	C0h	Write	PRA	PRD									

X = Don't Care, RA=Read Address, RD=Read Data, SRD=Status Register Data, ID=Identifier (Manufacture and Device Code), QA=Query Address, QD=Query Data, BA=Block Address, PA=Program Address, PD=Program Data, PRA=Protection Register Address, PRD=Protection Register Data.

- 2. 55h is reserved.
- 3. The signature addresses are listed in *Table 5*, *Table 6* and *Table 7*.
- 4. Program Addresses 1 and 2 must be consecutive Addresses differing only for A0.
- 5. Program Addresses 1,2,3 and 4 must be consecutive Addresses differing only for A0 and A1.
- 6. To be characterized.

22/69 Numonyx

Table 5. Read Electronic Signature⁽¹⁾

Code	Device	ΙE	IG	W	A0	A 1	A2-A7	A8-A20	DQ0-DQ7	DQ8-DQ15
Manufacture. Code		V_{IL}	V _{IL}	V _{IH}	V _{IL}	V _{IL}	0	Don't Care	20h	00h
Device Code	M28W320FCT	V_{IL}	V_{IL}	V_{IH}	V_{IH}	V_{IL}	0	Don't Care	BAh	88h
Device Code	M28W320FCB	V _{IL}	V _{IL}	V _{IH}	V _{IH}	V _{IL}	0	Don't Care	BBh	88h

^{1.} RP = V_{IH}.

Table 6. Read Block Lock Signature

Block Status	Ē	G	w	A0	A 1	A2-A7	A8-A11	A12-A20	DQ0	DQ1	DQ2-DQ15
Locked Block	V_{IL}	V_{IL}	V_{IH}	V_{IL}	V_{IH}	0	Don't Care	Block Address	1	0	00h
Unlocked Block	V_{IL}	V_{IL}	V_{IH}	V_{IL}	V_{IH}	0	Don't Care	Block Address	0	0	00h
Locked-Down Block	V _{IL}	V _{IL}	V _{IH}	V _{IL}	V _{IH}	0	Don't Care	Block Address	X ⁽¹⁾	1	00h

^{1.} A Locked-Down Block can be locked "DQ0 = 1" or unlocked "DQ0 = 0"; see Block Locking section.

Table 7. Read Protection Register and Lock Register

Word	Ē	G	w	A0- A7	A8-A20	DQ0	DQ1	DQ2	DQ3- DQ7	DQ8- DQ15
Lock	V_{IL}	V _{IL}	V _{IH}	80h	Don't Care	Don't Care	OTP Prot. data	Don't Care See note ⁽¹⁾	Don't Care	Don't Care
Unique ID 0	V_{IL}	V_{IL}	V_{IH}	81h	Don't Care	ID data	ID data	ID data	ID data	ID data
Unique ID 1	V_{IL}	V _{IL}	V _{IH}	82h	Don't Care	ID data	ID data	ID data	ID data	ID data
Unique ID 2	V_{IL}	V _{IL}	V _{IH}	83h	Don't Care	ID data	ID data	ID data	ID data	ID data
Unique ID 3	V_{IL}	V_{IL}	V_{IH}	84h	Don't Care	ID data	ID data	ID data	ID data	ID data
OTP 0	V _{IL}	V _{IL}	V _{IH}	85h	Don't Care	OTP data	OTP data	OTP data	OTP data	OTP data
OTP 1	V _{IL}	V _{IL}	V _{IH}	86h	Don't Care	OTP data	OTP data	OTP data	OTP data	OTP data
OTP 2	V _{IL}	V _{IL}	V _{IH}	87h	Don't Care	OTP data	OTP data	OTP data	OTP data	OTP data
OTP 3	V _{IL}	V _{IL}	V _{IH}	88h	Don't Care	OTP data	OTP data	OTP data	OTP data	OTP data
OTP 4	V _{IL}	V _{IL}	V _{IH}	89h	Don't Care	OTP data	OTP data	OTP data	OTP data	OTP data
OTP 5	V _{IL}	V _{IL}	V _{IH}	8Ah	Don't Care	OTP data	OTP data OTP data		OTP data	OTP data
OTP 6	V _{IL}	V _{IL}	V _{IH}	8Bh	Don't Care	OTP data	OTP data	OTP data	OTP data	OTP data
OTP 7	V _{IL}	V _{IL}	V _{IH}	8Ch	Don't Care	OTP data	OTP data	OTP data	OTP data	OTP data

^{1.} $\,$ DQ2 in the Protection Lock Register must not be programmed to 0.

Numonyx 23/69

Table 8. Program, Erase Times and Program/Erase Endurance Cycles

Danamatan	Tool Conditions	M28W3	M28W320FCT, M28W320FCB			
Parameter	Test Conditions	Min	Тур	Max	Unit	
Word Program	$V_{PP} = V_{DD}$		10	200	μs	
Double Word Program	V _{PP} = 12V ±5%		10	200	μs	
Quadruple Word Program	V _{PP} = 12V ±5%		10	200	μs	
Main Block Brogram	V _{PP} = 12V ±5%		0.16/0.08 (1)	5	S	
Main Block Program	$V_{PP} = V_{DD}$		0.32	5	s	
Description Disch Description	V _{PP} = 12V ±5%		0.02/0.01 ⁽¹⁾	4	s	
Parameter Block Program	V _{PP} = V _{DD}		0.04	4	S	
Main Block Erase	V _{PP} = 12V ±5%		1	10	S	
IVIAITI DIOCK ETASE	V _{PP} = V _{DD}		1	10	S	
Parameter Block Erase	V _{PP} = 12V ±5%		0.4	10	S	
raidilletei Diock Elase	$V_{PP} = V_{DD}$		0.4	10	S	
Program/Erase Cycles (per Block)		100,000			cycles	
Data Retention		20			years	

Typical time to program a Main or Parameter Block using the Double Word Program and the Quadruple Word Program commands respectively.

5 Block locking

The M28W320FCT and M28W320FCB feature an instant, individual block locking scheme that allows any block to be locked or unlocked with no latency. This locking scheme has three levels of protection.

- Lock/Unlock this first level allows software-only control of block locking.
- Lock-Down this second level requires hardware interaction before locking can be changed.
- V_{PP} ≤ V_{PPLK} the third level offers a complete hardware protection against program and erase on all blocks.

The protection status of each block can be set to Locked, Unlocked, and Lock-Down. *Table 10* defines all of the possible protection states (WP, DQ1, DQ0), and *Appendix C*, *Figure 22*, shows a flowchart for the locking operations.

5.1 Reading a Block's Lock Status

The lock status of every block can be read in the Read Electronic Signature mode of the device. To enter this mode write 90h to the device. Subsequent reads at the address specified in *Table 6*, will output the protection status of that block. The lock status is represented by DQ0 and DQ1. DQ0 indicates the Block Lock/Unlock status and is set by the Lock command and cleared by the Unlock command. It is also automatically set when entering Lock-Down. DQ1 indicates the Lock-Down status and is set by the Lock-Down command. It cannot be cleared by software, only by a hardware reset or power-down.

The following sections explain the operation of the locking system.

5.2 Locked state

The default status of all blocks on power-up or after a hardware reset is Locked (states (0,0,1) or (1,0,1)). Locked blocks are fully protected from any program or erase. Any program or erase operations attempted on a locked block will return an error in the Status Register. The Status of a Locked block can be changed to Unlocked or Lock-Down using the appropriate software commands. An Unlocked block can be Locked by issuing the Lock command.

5.3 Unlocked state

Unlocked blocks (states (0,0,0), (1,0,0) (1,1,0)), can be programmed or erased. All unlocked blocks return to the Locked state after a hardware reset or when the device is powered-down. The status of an unlocked block can be changed to Locked or Locked-Down using the appropriate software commands. A locked block can be unlocked by issuing the Unlock command.

5.4 Lock-Down state

Blocks that are Locked-Down (state (0,1,x))are protected from program and erase operations (as for Locked blocks) but their protection status cannot be changed using software commands alone. A Locked or Unlocked block can be Locked-Down by issuing the Lock-Down command. Locked-Down blocks revert to the Locked state when the device is reset or powered-down.

The Lock-Down function is dependent on the $\overline{\text{WP}}$ input pin. When $\overline{\text{WP}}$ =0 (V_{IL}), the blocks in the Lock-Down state (0,1,x) are protected from program, erase and protection status changes. When $\overline{\text{WP}}$ =1 (V_{IH}) the Lock-Down function is disabled (1,1,1) and Locked-Down blocks can be individually unlocked to the (1,1,0) state by issuing the software command, where they can be erased and programmed. These blocks can then be locked again (1,1,1) and unlocked (1,1,0) as desired while $\overline{\text{WP}}$ remains high. When $\overline{\text{WP}}$ is low, blocks that were previously Locked-Down return to the Lock-Down state (0,1,x) regardless of any changes made while $\overline{\text{WP}}$ was high. Device reset or power-down resets all blocks, including those in Lock-Down, to the Locked state.

5.5 Locking operations during Erase Suspend

Changes to block lock status can be performed during an erase suspend by using the standard locking command sequences to unlock, lock or lock-down a block. This is useful in the case when another block needs to be updated while an erase operation is in progress.

To change block locking during an erase operation, first write the Erase Suspend command, then check the status register until it indicates that the erase operation has been suspended. Next write the desired Lock command sequence to a block and the lock status will be changed. After completing any desired lock, read, or program operations, resume the erase operation with the Erase Resume command.

If a block is locked or locked-down during an erase suspend of the same block, the locking status bits will be changed immediately, but when the erase is resumed, the erase operation will complete.

Locking operations cannot be performed during a program suspend. Refer to *Appendix D:* Command interface and Program/Erase Controller state, for detailed information on which commands are valid during erase suspend.

Table 9. Block Lock Status

Item	Address	Data
Block Lock Configuration		LOCK
Block is Unlocked	xx002	DQ0=0
Block is Locked	***************************************	DQ0=1
Block is Locked-Down		DQ1=1

Table 10. Protection Status

	ection Status ⁽¹⁾ Q1, DQ0)	Next <u>Pro</u> tection Status ⁽¹⁾ (WP, DQ1, DQ0)					
Current State	Program/Erase Allowed	After Block Lock Command	After After Block Block Unlock Command Command		After WP transition		
1,0,0	yes	1,0,1	1,0,0	1,1,1	0,0,0		
1,0,1 ⁽²⁾	no	1,0,1	1,0,0	1,1,1	0,0,1		
1,1,0	yes	1,1,1	1,1,0	1,1,1	0,1,1		
1,1,1	no	1,1,1	1,1,0	1,1,1	0,1,1		
0,0,0	yes	0,0,1	0,0,0	0,1,1	1,0,0		
0,0,1 ⁽²⁾	no	0,0,1	0,0,0	0,1,1	1,0,1		
0,1,1	no	0,1,1	0,1,1	0,1,1	1,1,1 or 1,1,0 ⁽³⁾		

The lock status is defined by the write protect pin and by DQ1 ('1' for a locked-down block) and DQ0 ('1' for a locked block) as read in the Read Electronic Signature command with A1 = V_{IH} and A0 = V_{IL}.

^{2.} All blocks are locked at power-up, so the default configuration is 001 or 101 according to $\overline{\text{WP}}$ status.

^{3.} A $\overline{\text{WP}}$ transition to V_{IH} on a locked block will restore the previous DQ0 value, giving a 111 or 110.

6 Status Register

The Status Register provides information on the current or previous Program or Erase operation. The various bits convey information and errors on the operation. To read the Status register the Read Status Register command can be issued, refer to Read Status Register Command section. To output the contents, the Status Register is latched on the falling edge of the Chip Enable or Output Enable signals, and can be read until Chip Enable or Output Enable must be toggled to update the latched data.

Bus Read operations from any address always read the Status Register during Program and Erase operations.

The bits in the Status Register are summarized in *Table 11: Status Register Bits*. Refer to *Table 11* in conjunction with the following text descriptions.

6.1 Program/Erase Controller Status (Bit 7)

The Program/Erase Controller Status bit indicates whether the Program/Erase Controller is active or inactive. When the Program/Erase Controller Status bit is Low (set to '0'), the Program/Erase Controller is active; when the bit is High (set to '1'), the Program/Erase Controller is inactive, and the device is ready to process a new command.

The Program/Erase Controller Status is Low immediately after a Program/Erase Suspend command is issued until the Program/Erase Controller pauses. After the Program/Erase Controller pauses the bit is High.

During Program, Erase, operations the Program/Erase Controller Status bit can be polled to find the end of the operation. Other bits in the Status Register should not be tested until the Program/Erase Controller completes the operation and the bit is High.

After the Program/Erase Controller completes its operation the Erase Status, Program Status, V_{PP} Status and Block Lock Status bits should be tested for errors.

6.2 Erase Suspend Status (Bit 6)

The Erase Suspend Status bit indicates that an Erase operation has been suspended or is going to be suspended. When the Erase Suspend Status bit is High (set to '1'), a Program/Erase Suspend command has been issued and the memory is waiting for a Program/Erase Resume command.

The Erase Suspend Status should only be considered valid when the Program/Erase Controller Status bit is High (Program/Erase Controller inactive). Bit 7 is set within 30µs of the Program/Erase Suspend command being issued therefore the memory may still complete the operation rather than entering the Suspend mode.

When a Program/Erase Resume command is issued the Erase Suspend Status bit returns Low.

6.3 Erase Status (Bit 5)

The Erase Status bit can be used to identify if the memory has failed to verify that the block has erased correctly. When the Erase Status bit is High (set to '1'), the Program/Erase Controller has applied the maximum number of pulses to the block and still failed to verify that the block has erased correctly. The Erase Status bit should be read once the Program/Erase Controller Status bit is High (Program/Erase Controller inactive).

Once set High, the Erase Status bit can only be reset Low by a Clear Status Register command or a hardware reset. If set High it should be reset before a new Program or Erase command is issued, otherwise the new command will appear to fail.

6.4 Program Status (Bit 4)

The Program Status bit is used to identify a Program failure. When the Program Status bit is High (set to '1'), the Program/Erase Controller has applied the maximum number of pulses to the byte and still failed to verify that it has programmed correctly. The Program Status bit should be read once the Program/Erase Controller Status bit is High (Program/Erase Controller inactive).

Once set High, the Program Status bit can only be reset Low by a Clear Status Register command or a hardware reset. If set High it should be reset before a new command is issued, otherwise the new command will appear to fail.

6.5 V_{PP} Status (Bit 3)

The V_{PP} Status bit can be used to identify an invalid voltage on the V_{PP} pin during Program and Erase operations. The V_{PP} pin is only sampled at the beginning of a Program or Erase operation. Indeterminate results can occur if V_{PP} becomes invalid during an operation.

When the V_{PP} Status bit is Low (set to '0'), the voltage on the V_{PP} pin was sampled at a valid voltage; when the V_{PP} Status bit is High (set to '1'), the V_{PP} pin has a voltage that is below the V_{PP} Lockout Voltage, V_{PPLK} , the memory is protected and Program and Erase operations cannot be performed.

Once set High, the V_{PP} Status bit can only be reset Low by a Clear Status Register command or a hardware reset. If set High it should be reset before a new Program or Erase command is issued, otherwise the new command will appear to fail.

6.6 Program Suspend Status (Bit 2)

The Program Suspend Status bit indicates that a Program operation has been suspended. When the Program Suspend Status bit is High (set to '1'), a Program/Erase Suspend command has been issued and the memory is waiting for a Program/Erase Resume command. The Program Suspend Status should only be considered valid when the Program/Erase Controller Status bit is High (Program/Erase Controller inactive). Bit 2 is set within 5µs of the Program/Erase Suspend command being issued therefore the memory may still complete the operation rather than entering the Suspend mode.

When a Program/Erase Resume command is issued the Program Suspend Status bit returns Low.

6.7 Block Protection Status (Bit 1)

The Block Protection Status bit can be used to identify if a Program or Erase operation has tried to modify the contents of a locked block.

When the Block Protection Status bit is High (set to '1'), a Program or Erase operation has been attempted on a locked block.

Once set High, the Block Protection Status bit can only be reset Low by a Clear Status Register command or a hardware reset. If set High it should be reset before a new command is issued, otherwise the new command will appear to fail.

6.8 Reserved (Bit 0)

Bit 0 of the Status Register is reserved. Its value must be masked.

Note: Refer to Appendix C: Flowcharts and pseudo codes, for using the Status Register.

Table 11. Status Register Bits

Bit	Name	Logic Level ⁽¹⁾	Definition
7	P/E.C. Status	'1'	Ready
/	P/E.C. Status	'0'	Busy
6	Erosa Cuanand Status	'1'	Suspended
0	Erase Suspend Status	'0'	In progress or Completed
5	Erase Status	'1'	Erase Error
5	Erase Status	'0'	Erase Success
4	Drogram Status	'1'	Program Error
4	Program Status	'0'	Program Success
3	V Status	'1'	V _{PP} Invalid, Abort
3	V _{PP} Status	'0'	V _{PP} OK
2	Program Suspend Status	'1'	Suspended
2	Program Suspend Status	'0'	In Progress or Completed
1	Block Protection Status	'1'	Program/Erase on protected Block, Abort
	BIOCK FIOLECTION Status	'0'	No operation to protected blocks
0	Reserved		

^{1.} Logic level '1' is High, '0' is Low.

7 Maximum rating

Stressing the device above the rating listed in the Absolute Maximum Ratings table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the Numonyx SURE Program and other relevant quality documents.

Table 12. Absolute Maximum Ratings

Symbol	Parameter	Valu	Unit		
Symbol	Parameter	Min	Max	Unit	
T _A	Ambient Operating Temperature ⁽¹⁾	- 40	85	°C	
T _{BIAS}	Temperature Under Bias	- 40	125	°C	
T _{STG}	Storage Temperature	– 55	155	°C	
V _{IO}	Input or Output Voltage	- 0.6	V _{DDQ} +0.6	V	
V _{DD} , V _{DDQ}	Supply Voltage	- 0.6	4.1	V	
V _{PP}	Program Voltage	- 0.6	13	V	

^{1.} Depends on range.

8 DC and AC parameters

This section summarizes the operating and measurement conditions, and the DC and AC characteristics of the device. The parameters in the DC and AC characteristics Tables that follow are derived from tests performed under the Measurement Conditions summarized in *Table 13*. Designers should check that the operating conditions in their circuit match the measurement conditions when relying on the quoted parameters.

Table 13. Operating and AC Measurement Conditions

	M28W320FCT, M28W320FCB									
Parameter	70		85		90		10			
	Min	Max	Min	Max	Min	Max	Min	Max	Units	
V _{DD} Supply Voltage	2.7	3.6	2.7	3.6	2.7	3.6	2.7	3.6	V	
V_{DDQ} Supply Voltage $(V_{DDQ} \le V_{DD})$	2.7	3.6	2.7	3.6	2.7	3.6	1.65	3.6	V	
Ambient Operating Temperature	- 40	85	- 40	85	- 40	85	- 40	85	°C	
Load Capacitance (C _L)	5	0	50		50		50		pF	
Input Rise and Fall Times		5		5		5		5	ns	
Input Pulse Voltages	0 to V _{DDQ}		0 to V _{DDQ}		0 to V _{DDQ}		0 to V _{DDQ}		V	
Input and Output Timing Ref. Voltages	V _{DI}	V _{DDQ} /2		V _{DDQ} /2		V _{DDQ} /2		V _{DDQ} /2		

Figure 6. AC Measurement I/O Waveform

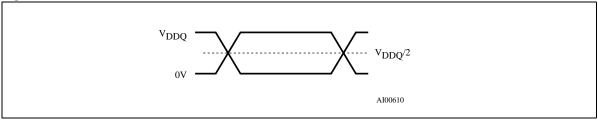


Figure 7. AC Measurement Load Circuit

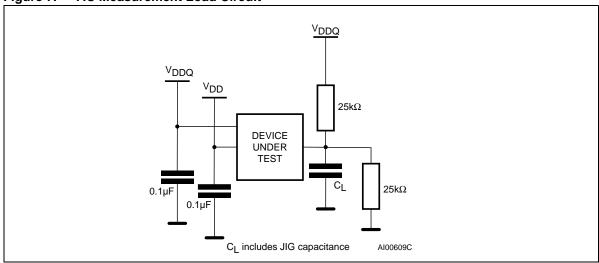


Table 14. Capacitance⁽¹⁾

Symbol	Parameter	Test Condition	Min	Max	Unit
C _{IN}	Input Capacitance	V _{IN} = 0V		6	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0V		12	pF

^{1.} Sampled only, not 100% tested.

Table 15. DC Characteristics

Symbol	Parameter	Test Condition	Min Typ		Max	Unit
I _{LI}	Input Leakage Current	$0V \le V_{IN} \le V_{DDQ}$			±1	μΑ
I _{LO}	Output Leakage Current	0V≤ V _{OUT} ≤V _{DDQ}			±10	μA
I _{DD}	Supply Current (Read)	$\overline{E} = V_{SS}, \overline{G} = V_{IH}, f = 5MHz$		9	18	mA
I _{DD1}	Supply Current (Stand-by or Automatic Stand-by)	$\overline{E} = V_{DDQ} \pm 0.2V,$ $\overline{RP} = V_{DDQ} \pm 0.2V$		15	50	μΑ
I _{DD2}	Supply Current (Reset)	$\overline{RP} = V_{SS} \pm 0.2V$		15	50	μА
	Supply Current (Program)	Program in progress V _{PP} = 12V ± 5%		5	10	mA
I _{DD3}	Supply Current (Program)	Program in progress V _{PP} = V _{DD}		10	20	mA
	Supply Current (Frace)	Erase in progress V _{PP} = 12V ± 5%		5	20	mA
I _{DD4}	Supply Current (Erase)	Erase in progress V _{PP} = V _{DD}	gress		20	mA
I _{DD5}	Supply Current (Program/Erase Suspend)	$\overline{E} = V_{DDQ} \pm 0.2V$, Erase suspended		15	50	μΑ
I _{PP}	Program Current (Read or Stand-by)	V _{PP} > V _{DD}			400	μΑ

Numonyx 33/69

Table 15. DC Characteristics (continued)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
I _{PP1}	Program Current (Read or Stand-by)	V _{PP} ≤ V _{DD}		1	5	μA
I _{PP2}	Program Current (Reset)	$\overline{RP} = V_{SS} \pm 0.2V$		1	5	μΑ
1	Program Current (Program)	Program in progress V _{PP} = 12V ± 5%		1	10	mA
I _{PP3}	Frogram Current (Frogram)	Program in progress V _{PP} = V _{DD}		1	5	μA
1	Program Current (France)	Erase in progress V _{PP} = 12V ± 5%		3	10	mA
I _{PP4}	Program Current (Erase)	Erase in progress $V_{PP} = V_{DD}$		1 5 0.4 0.8	5	μA
\/	Input Low Voltage		-0.5		0.4	V
V_{IL}	Input Low Voltage	V _{DDQ} ≥ 2.7V	-0.5		0.8	V
V	Input High Voltage		V _{DDQ} –0.4		V _{DDQ} +0.4	V
V_{IH}	Input High Voltage	$V_{DDQ} \ge 2.7V$	0.7 V _{DDQ}		V _{DDQ} +0.4	V
V_{OL}	Output Low Voltage	I_{OL} = 100 μ A, V_{DD} = V_{DD} min, V_{DDQ} = V_{DDQ} min			0.1	٧
V_{OH}	Output High Voltage	$I_{OH} = -100\mu A$, $V_{DD} = V_{DD} min$, $V_{DDQ} = V_{DDQ} min$	V _{DDQ} -0.1			٧
V_{PP1}	Program Voltage (Program or Erase operations)		1.65		3.6	٧
V_{PPH}	Program Voltage (Program or Erase operations)		11.4		12.6	٧
V _{PPLK}	Program Voltage (Program and Erase lock- out)				1	V
V_{LKO}	V _{DD} Supply Voltage (Program and Erase lock- out)				2	٧

tAVAV VALID A0-A20 tAVQVtAXQX Ē tELQV tEHQX tELQX tEHQZ G tGLQV -tGHQX → tGLQX -- tGHQZ -VALID DQ0-DQ15 OUTPUTS. ◆ ADDR. VALID → ★ → DATA VALID → -STANDBY **ENABLED** CHIP ENABLE AI02688b

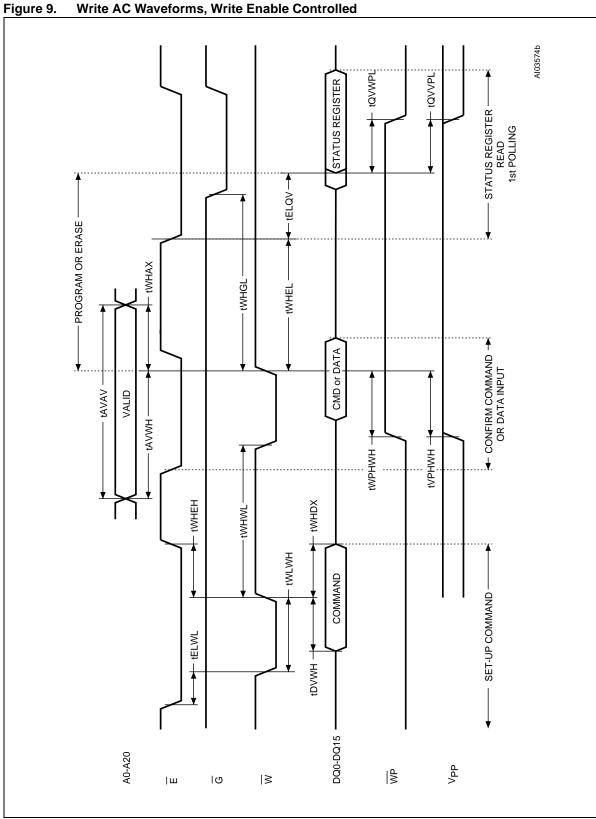
Figure 8. Read AC Waveforms

Table 16. Read AC Characteristics

0	Ali Barrandari		M28W320FCT, M28W320FCB					1114
Symbol	Alt	Parameter		70	85	90	10	Unit
t _{AVAV}	t _{RC}	Address Valid to Next Address Valid	Min	70	85	90	100	ns
t _{AVQV}	t _{ACC}	Address Valid to Output Valid	Max	70	85	90	100	ns
t _{AXQX} ⁽¹⁾	t _{OH}	Address Transition to Output Transition	Min	0	0	0	0	ns
t _{EHQX} ⁽¹⁾	t _{OH}	Chip Enable High to Output Transition	Min	0	0	0	0	ns
t _{EHQZ} ⁽¹⁾	t _{HZ}	Chip Enable High to Output Hi-Z	Max	20	20	25	30	ns
t _{ELQV} ⁽²⁾	t _{CE}	Chip Enable Low to Output Valid	Max	70	85	90	100	ns
t _{ELQX} ⁽¹⁾	t_{LZ}	Chip Enable Low to Output Transition	Min	0	0	0	0	ns
t _{GHQX} ⁽¹⁾	t _{OH}	Output Enable High to Output Transition	Min	0	0	0	0	ns
t _{GHQZ} ⁽¹⁾	t _{DF}	Output Enable High to Output Hi-Z	Max	20	20	25	30	ns
t _{GLQV} ⁽²⁾	t _{OE}	Output Enable Low to Output Valid	Max	20	20	30	35	ns
t _{GLQX} ⁽¹⁾	t _{OLZ}	Output Enable Low to Output Transition	Min	0	0	0	0	ns

^{1.} Sampled only, not 100% tested.

^{2.} \overline{G} may be delayed by up to t_{ELQV} - t_{GLQV} after the falling edge of \overline{E} without increasing t_{ELQV} .



36/69 **N** numonyx

Table 17. Write AC Characteristics, Write Enable Controlled

		<u> </u>	M28W	/320FCT,	M28W32	0FCB		
Symbol	Alt	Parameter	Parameter		85	90	10	Unit
t _{AVAV}	t_{WC}	Write Cycle Time	Min	70	85	90	100	ns
t _{AVWH}	t _{AS}	Address Valid to Write Enable High	Min	45	45	50	50	ns
t _{DVWH}	t _{DS}	Data Valid to Write Enable High	Min	45	45	50	50	ns
t _{ELWL}	t _{CS}	Chip Enable Low to Write Enable Low	Min	0	0	0	0	ns
t _{ELQV}		Chip Enable Low to Output Valid	Min	70	85	90	100	ns
t _{QVVPL} ⁽¹⁾⁽²⁾		Output Valid to V _{PP} Low	Min	0	0	0	0	ns
t _{QVWPL}		Output Valid to Write Protect Low	Min	0	0	0	0	ns
t _{VPHWH} ⁽¹⁾	t _{VPS}	V _{PP} High to Write Enable High	Min	200	200	200	200	ns
t _{WHAX}	t _{AH}	Write Enable High to Address Transition	Min	0	0	0	0	ns
t _{WHDX}	t _{DH}	Write Enable High to Data Transition	Min	0	0	0	0	ns
t _{WHEH}	t _{CH}	Write Enable High to Chip Enable High	Min	0	0	0	0	ns
t _{WHEL}		Write Enable High to Chip Enable Low	Min	25	25	30	30	ns
t _{WHGL}		Write Enable High to Output Enable Low	Min	20	20	30	30	ns
t _{WHWL}	t_{WPH}	Write Enable High to Write Enable Low	Min	25	25	30	30	ns
t _{WLWH}	t_{WP}	Write Enable Low to Write Enable High	Min	45	45	50	50	ns
t _{WPHWH}		Write Protect High to Write Enable High	Min	45	45	50	50	ns

^{1.} Sampled only, not 100% tested.

^{2.} Applicable if V_{PP} is seen as a logic input (V_{PP} < 3.6V).

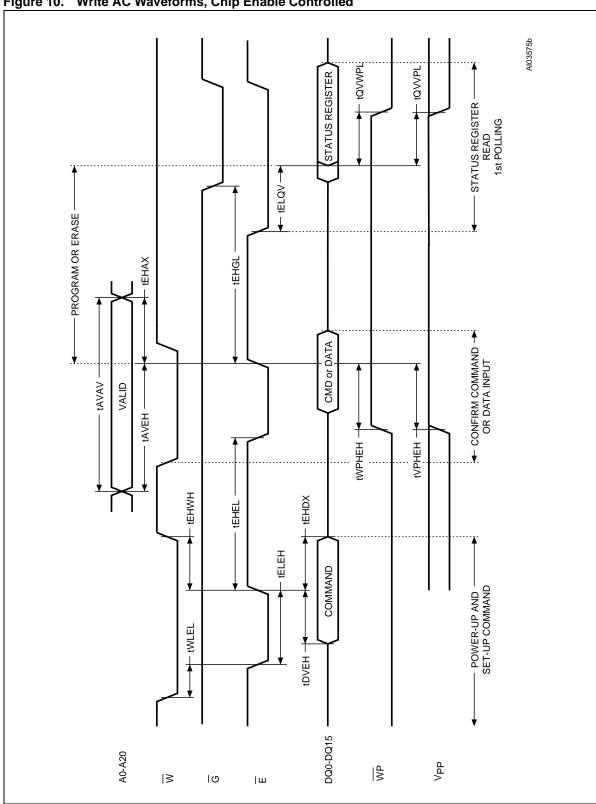


Figure 10. Write AC Waveforms, Chip Enable Controlled

38/69 **N** numonyx

Table 18. Write AC Characteristics, Chip Enable Controlled

		.	Parameter –		W320FCT,	M28W32	0FCB	
Symbol	Alt	Parameter			85	90	10	Unit
t _{AVAV}	t _{WC}	Write Cycle Time	Min	70	85	90	100	ns
t _{AVEH}	t _{AS}	Address Valid to Chip Enable High	Min	45	45	50	50	ns
t _{DVEH}	t _{DS}	Data Valid to Chip Enable High	Min	45	45	50	50	ns
t _{EHAX}	t _{AH}	Chip Enable High to Address Transition	Min	0	0	0	0	ns
t _{EHDX}	t _{DH}	Chip Enable High to Data Transition	Min	0	0	0	0	ns
t _{EHEL}	t _{CPH}	Chip Enable High to Chip Enable Low	Min	25	25	30	30	ns
t _{EHGL}		Chip Enable High to Output Enable Low	Min	25	25	30	30	ns
t _{EHWH}	t _{WH}	Chip Enable High to Write Enable High	Min	0	0	0	0	ns
t _{ELEH}	t _{CP}	Chip Enable Low to Chip Enable High	Min	45	45	50	50	ns
t _{ELQV}		Chip Enable Low to Output Valid	Min	70	85	90	100	ns
t _{QVVPL} ⁽¹⁾ (2)		Output Valid to V _{PP} Low	Min	0	0	0	0	ns
t _{QVWPL}		Data Valid to Write Protect Low	Min	0	0	0	0	ns
t _{VPHEH} ⁽¹⁾	t _{VPS}	V _{PP} High to Chip Enable High	Min	200	200	200	200	ns
t _{WLEL}	t _{CS}	Write Enable Low to Chip Enable Low	Min	0	0	0	0	ns
t _{WPHEH}		Write Protect High to Chip Enable High	Min	45	45	50	50	ns

^{1.} Sampled only, not 100% tested.

^{2.} Applicable if V_{PP} is seen as a logic input (V_{PP} < 3.6V).

Figure 11. Power-Up and Reset AC Waveforms

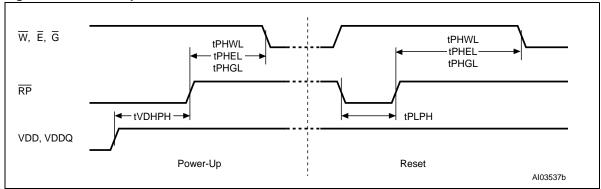


Table 19. Power-Up and Reset AC Characteristics

Symbol	Parameter	Test Cond	ition	M28W320FCT, M28W320FCB			Unit	
Syllibol	r at affecter fest condition				85	90	10	Oilit
t _{PHWL}	Reset High to Write Enable Low, Chip Enable Low, Output Enable Low	During Program and Erase	Min	50	50	50	50	μs
t _{PHGL}		others	Min	30	30	30	30	ns
t _{PLPH} ⁽¹⁾⁽²⁾	Reset Low to Reset High		Min	100	100	100	100	ns
t _{VDHPH} ⁽³⁾	Supply Voltages High to Reset High		Min	50	50	50	50	μs

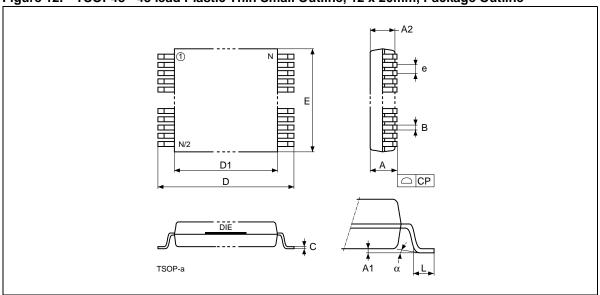
^{1.} The device Reset is possible but not guaranteed if t_{PLPH} < 100ns.

^{2.} Sampled only, not 100% tested.

^{3.} It is important to assert $\overline{\text{RP}}$ in order to allow proper CPU initialization during power up or reset.

9 Package mechanical

Figure 12. TSOP48 - 48 lead Plastic Thin Small Outline, 12 x 20mm, Package Outline



^{1.} Drawing is not to scale.

Table 20. TSOP48 - 48 lead Plastic Thin Small Outline, 12 x 20mm, Package Mechanical Data

Symbol		mm			inches	
Symbol	Тур	Min	Max	Тур	Min	Max
А			1.20			0.0472
A1		0.05	0.15		0.0020	0.0059
A2		0.95	1.05		0.0374	0.0413
В		0.17	0.27		0.0067	0.0106
С		0.10	0.21		0.0039	0.0083
D		19.80	20.20		0.7795	0.7953
D1		18.30	18.50		0.7205	0.7283
Е		11.90	12.10		0.4685	0.4764
е	0.50	_	-	0.0197	-	-
L		0.50	0.70		0.0197	0.0279
α		0°	5°		0°	5°
N		48			48	
CP			0.10			0.0039

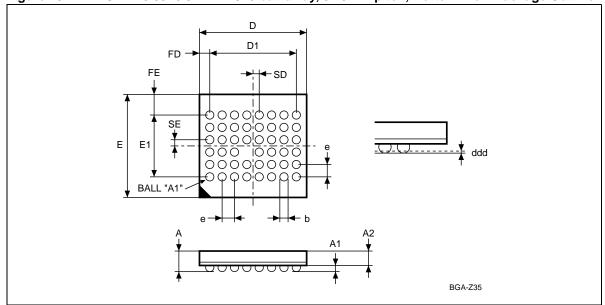


Figure 13. TFBGA47 6.39x6.37mm - 8x6 ball array, 0.75mm pitch, Bottom View Package Outline

1. Drawing is not to scale.

Table 21. TFBGA47 6.39x6.37mm - 8x6 ball array, 0.75mm pitch, Package Mechanical Data

Sumah al		millimeters			inches	
Symbol	Тур	Min	Max	Тур	Min	Max
А			1.200			0.0472
A1		0.200			0.0079	
A2			1.000			0.0394
b	0.400	0.350	0.450	0.0157	0.0138	0.0177
D	6.390	6.290	6.490	0.2516	0.2476	0.2555
D1	5.250	-	-	0.2067	-	-
ddd			0.100			0.0039
E	6.370	6.270	6.470	0.2508	0.2469	0.2547
E1	3.750	-	=	0.1476	-	-
е	0.750	-	-	0.0295	-	-
FD	0.570	-	-	0.0224	-	-
FE	1.310	-	-	0.0516	-	-
SD	0.375	-	-	0.0148	-	-
SE	0.375	-	-	0.0148	-	-

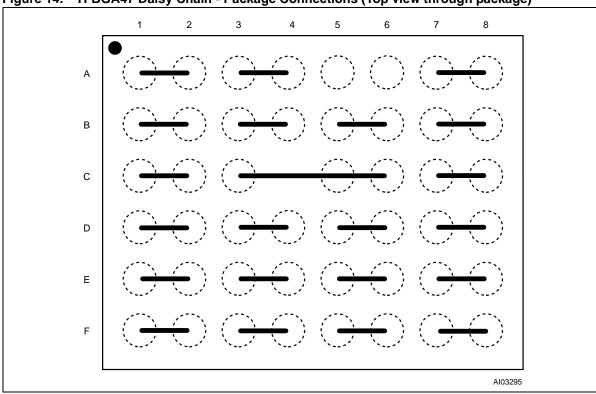
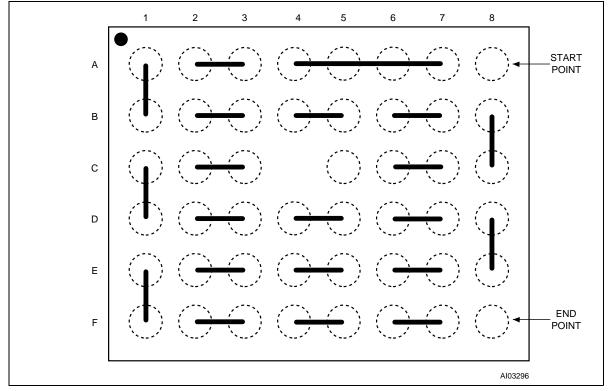


Figure 14. TFBGA47 Daisy Chain - Package Connections (Top view through package)

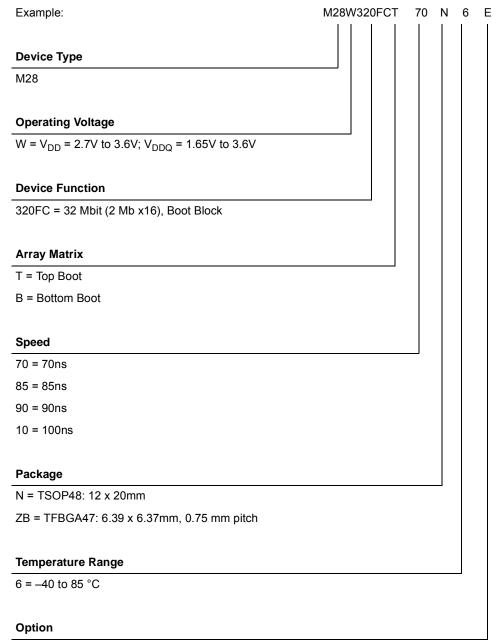




№ numonyx
43/69

10 Part numbering

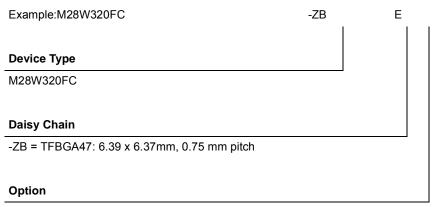
Table 22. Ordering Information Scheme



E = RoHS compliant Package, Standard Packing

F = RoHS compliant Package, Tape & Reel 24mm Packing

Table 23. Daisy Chain Ordering Scheme



E = RoHS compliant Package, Standard Packing

F = RoHS compliant Package, Tape & Reel 24mm Packing

Devices are shipped from the factory with the memory content bits erased to '1'. For a list of available options (Speed, Package, etc.) or for further information on any aspect of this device, please contact the Numonyx Sales Office nearest to you.

Appendix A Block address tables

Table 24. Top Boot Block Addresses, M28W320FCT

0 4 1FF000-1FFFF 1 4 1FE000-1FEFFF 2 4 1FD000-1FDFFF 3 4 1FC000-1FCFFF 4 4 1FB000-1FBFFF 5 4 1FA000-1FAFFF 6 4 1F9000-1F9FFF 7 4 1F8000-1F8FFF 8 32 1F0000-1F7FFF 9 32 1E8000-1EFFFF 10 32 1E0000-1FFFF 11 32 1D8000-1DFFFF 12 32 1D0000-1DFFFF 13 32 1C8000-1CFFFF 14 32 1C8000-1CFFFF 15 32 1B8000-1BFFFF 16 32 1B8000-1BFFFF 17 32 1A8000-1AFFFF 18 32 1A9000-1AFFFF 19 32 198000-19FFFF 20 32 198000-19FFFF 21 32 188000-18FFFF 22 32 188000-18FFFF	#	Size (KWord)	Address Range
2 4 1FD000-1FDFFF 3 4 1FC000-1FCFFF 4 4 1FB000-1FBFFF 5 4 1FA000-1FAFFF 6 4 1F9000-1F9FFF 7 4 1F8000-1FFFF 8 32 1F0000-1FFFF 9 32 1E8000-1EFFF 10 32 1D0000-1FFFF 11 32 1D0000-1DFFFF 12 32 1D0000-1DFFFF 13 32 1C8000-1CFFFF 14 32 1C0000-1CFFFF 15 32 1B8000-1BFFFF 16 32 1B0000-1BFFFF 17 32 1A8000-1AFFFF 18 32 19000-19FFF 20 32 19000-19FFF 21 32 188000-18FFF 22 32 18000-18FFF 23 32 178000-17FFF 24 32 170000-177FFF 25 32 168000-16FFFF 26 32 168000-16FFFF 26 32	0	4	1FF000-1FFFFF
3 4 1FC000-1FCFFF 4 4 1FB000-1FBFFF 5 4 1FA000-1FAFFF 6 4 1F9000-1F9FFF 7 4 1F8000-1F8FFF 8 32 1F0000-1F7FF 9 32 1E8000-1EFFFF 10 32 1D8000-1DFFFF 11 32 1D8000-1DFFFF 12 32 1D0000-1D7FFF 13 32 1C8000-1CFFFF 14 32 1C0000-1CFFFF 15 32 1B8000-1BFFFF 16 32 1B8000-1BFFFF 17 32 1A8000-1AFFFF 18 32 198000-19FFFF 20 32 198000-19FFFF 21 32 188000-18FFFF 22 32 188000-18FFFF 23 32 178000-17FFF 24 32 178000-17FFFF 25 32 168000-16FFFF 26 32 168000-16FFFF 26 32 158000-15FFFF 28	1	4	1FE000-1FEFFF
4 4 4 1FB000-1FBFFF 5 4 1FA000-1FAFFF 6 4 1F9000-1F9FFF 7 4 1F8000-1F9FFF 7 4 1F8000-1F9FFF 8 32 1F0000-1F7FFF 9 32 1E8000-1EFFFF 10 32 1D8000-1DFFFF 11 32 1D8000-1DFFFF 13 32 1C8000-1CFFFF 14 32 1C0000-1CFFFF 15 32 1B8000-1BFFFF 16 32 1B8000-1BFFFF 17 32 1A8000-1AFFFF 18 32 1A8000-1AFFFF 19 32 198000-19FFF 20 32 198000-19FFF 21 32 188000-18FFF 22 32 188000-18FFF 24 32 178000-17FFF 25 32 188000-18FFF 26 32 178000-17FFF 27 32 168000-16FFF 28 32 168000-16FFFF 29 32 168000-16FFFF 29 32 168000-16FFFF 29 32 168000-16FFFF 29 32 158000-15FFFF 29 32 158000-15FFFF 29 32 158000-15FFFF 29 32 148000-15FFFF 29 32 148000-15FFFF 29 32 148000-15FFFF 29 32 148000-14FFFF 29 32 148000-14FFFF	2	4	1FD000-1FDFFF
5 4 1FA000-1FAFFF 6 4 1F9000-1F9FFF 7 4 1F8000-1F8FFF 8 32 1F0000-1F7FFF 9 32 1E8000-1EFFFF 10 32 1D8000-1DFFFF 11 32 1D8000-1DFFFF 12 32 1D0000-1DFFFF 13 32 1C8000-1CFFFF 14 32 1C0000-1CFFFF 15 32 1B8000-1BFFFF 16 32 1B8000-1BFFFF 17 32 1A8000-1AFFFF 18 32 198000-19FFFF 20 32 198000-19FFFF 21 32 188000-18FFFF 22 32 18000-18FFFF 23 32 178000-17FFFF 24 32 178000-17FFFF 25 32 168000-16FFFF 26 32 168000-16FFFF 26 32 158000-15FFFF 28 32 158000-15FFFF 29 32 148000-14FFFF	3	4	1FC000-1FCFFF
6 4 1F9000-1F9FFF 7 4 1F8000-1F8FFF 8 32 1F0000-1F7FFF 9 32 1E8000-1EFFFF 10 32 1D8000-1DFFFF 11 32 1D0000-1DFFFF 12 32 1D0000-1DFFFF 13 32 1C8000-1CFFFF 14 32 1C0000-1CFFFF 15 32 1B8000-1BFFFF 16 32 1B8000-1BFFFF 17 32 1A8000-1AFFFF 18 32 198000-19FFF 20 32 198000-19FFF 21 32 188000-18FFFF 22 32 188000-18FFFF 23 32 178000-17FFFF 24 32 178000-17FFFF 25 32 168000-16FFFF 26 32 168000-16FFFF 26 32 158000-15FFFF 28 32 158000-15FFFF 29 32 148000-14FFFF	4	4	1FB000-1FBFFF
7 4 1F8000-1F8FFF 8 32 1F0000-1F7FFF 9 32 1E8000-1EFFFF 10 32 1E0000-1E7FFF 11 32 1D8000-1DFFFF 12 32 1D0000-1D7FFF 13 32 1C8000-1CFFFF 14 32 1C0000-1CFFFF 15 32 1B8000-1BFFFF 16 32 1B8000-1BFFFF 17 32 1A8000-1AFFFF 18 32 19000-19FFFF 20 32 19000-19FFFF 21 32 188000-18FFFF 22 32 18000-18FFFF 23 32 178000-17FFFF 24 32 178000-17FFFF 25 32 168000-16FFFF 26 32 168000-16FFFF 26 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-147FFF	5	4	1FA000-1FAFFF
8 32 1F0000-1F7FFF 9 32 1E8000-1EFFFF 10 32 1E0000-1E7FFF 11 32 1D8000-1DFFFF 12 32 1D0000-1CFFFF 13 32 1C8000-1CFFFF 14 32 1C0000-1CFFFF 15 32 1B8000-1BFFFF 16 32 1B8000-1BFFFF 17 32 1A8000-1AFFFF 18 32 19000-19FFFF 20 32 19000-19FFFF 20 32 19000-19FFFF 21 32 188000-18FFFF 22 32 18000-18FFFF 23 32 178000-17FFFF 24 32 178000-17FFFF 25 32 168000-16FFFF 26 32 168000-16FFFF 26 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-147FFF	6	4	1F9000-1F9FFF
9 32 1E8000-1EFFFF 10 32 1E0000-1E7FFF 11 32 1D8000-1DFFFF 12 32 1D0000-1DFFFF 13 32 1C8000-1CFFFF 14 32 1C0000-1CFFFF 15 32 1B8000-1BFFFF 16 32 1B0000-1BFFFF 17 32 1A8000-1AFFFF 18 32 1A0000-1AFFFF 19 32 198000-19FFFF 20 32 198000-19FFFF 21 32 188000-18FFFF 22 32 180000-18FFFF 23 32 18000-18FFFF 24 32 170000-17FFF 25 32 168000-16FFFF 26 32 168000-16FFFF 27 32 158000-16FFFF 28 32 158000-15FFFF 29 32 158000-15FFFF 29 32 148000-15FFFF	7	4	1F8000-1F8FFF
10 32 1E0000-1E7FFF 11 32 1D8000-1DFFFF 12 32 1D0000-1D7FFF 13 32 1C8000-1CFFFF 14 32 1C0000-1C7FFF 15 32 1B8000-1BFFFF 16 32 1B0000-1B7FFF 17 32 1A8000-1AFFFF 18 32 198000-19FFF 19 32 198000-19FFF 20 32 190000-19FFF 21 32 188000-18FFF 22 32 180000-18FFF 23 32 178000-17FFF 24 32 170000-17FFF 25 32 168000-16FFF 26 32 168000-16FFF 26 32 158000-15FFF 28 32 150000-15FFF 28 32 148000-14FFFF 30 32 148000-14FFFF	8	32	1F0000-1F7FFF
11 32 1D8000-1DFFFF 12 32 1D0000-1D7FFF 13 32 1C8000-1CFFFF 14 32 1C0000-1C7FFF 15 32 1B8000-1BFFFF 16 32 1B0000-1B7FFF 17 32 1A8000-1AFFFF 18 32 1A0000-1AFFFF 19 32 198000-19FFFF 20 32 190000-197FFF 21 32 188000-18FFFF 22 32 180000-187FFF 23 32 178000-17FFFF 24 32 170000-17FFFF 25 32 168000-16FFFF 26 32 168000-16FFFF 27 32 158000-15FFFF 28 32 150000-15FFFF 29 32 148000-14FFFF	9	32	1E8000-1EFFFF
12 32 1D0000-1D7FFF 13 32 1C8000-1CFFFF 14 32 1C0000-1C7FFF 15 32 1B8000-1BFFFF 16 32 1B0000-1B7FFF 17 32 1A8000-1AFFFF 18 32 1A0000-1A7FFF 19 32 198000-19FFF 20 32 190000-197FFF 21 32 188000-18FFFF 22 32 180000-18FFFF 23 32 178000-17FFFF 24 32 170000-177FFF 25 32 168000-16FFFF 26 32 168000-16FFFF 27 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-14FFFF 30 32 140000-147FFF	10	32	1E0000-1E7FFF
13 32 1C8000-1CFFFF 14 32 1C0000-1C7FFF 15 32 1B8000-1BFFFF 16 32 1B0000-1B7FFF 17 32 1A8000-1AFFFF 18 32 198000-19FFFF 19 32 198000-19FFFF 20 32 190000-197FFF 21 32 188000-18FFFF 22 32 178000-18FFFF 23 32 178000-17FFFF 24 32 170000-177FFF 25 32 168000-16FFFF 26 32 160000-16FFFF 27 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-14FFFF	11	32	1D8000-1DFFFF
14 32 1C0000-1C7FFF 15 32 1B8000-1BFFFF 16 32 1B0000-1B7FFF 17 32 1A8000-1AFFFF 18 32 1A0000-1A7FFF 19 32 198000-19FFFF 20 32 190000-197FFF 21 32 188000-18FFFF 22 32 180000-187FFF 23 32 178000-17FFFF 24 32 170000-17FFFF 25 32 168000-16FFFF 26 32 168000-16FFFF 27 32 158000-15FFFF 28 32 150000-15FFFF 29 32 148000-14FFFF 30 32 140000-147FFF	12	32	1D0000-1D7FFF
15 32 188000-18FFFF 16 32 180000-187FFF 17 32 1A8000-1AFFFF 18 32 1A0000-1A7FFF 19 32 198000-19FFFF 20 32 190000-197FFF 21 32 188000-18FFFF 22 32 180000-187FFF 23 32 178000-17FFFF 24 32 170000-177FFF 25 32 168000-16FFFF 26 32 160000-167FFF 27 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-14FFFF 30 32 140000-147FFF	13	32	1C8000-1CFFFF
16 32 1B0000-1B7FFF 17 32 1A8000-1AFFFF 18 32 1A0000-1A7FFF 19 32 198000-19FFF 20 32 190000-197FFF 21 32 188000-18FFFF 22 32 180000-187FFF 23 32 178000-17FFFF 24 32 170000-17FFFF 25 32 168000-16FFFF 26 32 160000-16FFFF 27 32 158000-15FFFF 28 32 150000-15FFFF 29 32 148000-14FFFF 30 32 140000-147FFF	14	32	1C0000-1C7FFF
17 32 1A8000-1AFFFF 18 32 1A0000-1A7FFF 19 32 198000-19FFFF 20 32 190000-197FFF 21 32 188000-18FFFF 22 32 180000-187FFF 23 32 178000-17FFFF 24 32 170000-177FFF 25 32 168000-16FFFF 26 32 160000-167FFF 27 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-147FFF 30 32 140000-147FFF	15	32	1B8000-1BFFFF
18 32 1A0000-1A7FFF 19 32 198000-19FFFF 20 32 190000-197FFF 21 32 188000-18FFFF 22 32 180000-187FFF 23 32 178000-17FFFF 24 32 170000-177FFF 25 32 168000-16FFFF 26 32 158000-15FFFF 27 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-14FFFF 30 32 140000-147FFF	16	32	1B0000-1B7FFF
19 32 198000-19FFF 20 32 190000-197FFF 21 32 188000-18FFFF 22 32 180000-187FFF 23 32 178000-17FFFF 24 32 170000-177FFF 25 32 168000-16FFFF 26 32 160000-167FFF 27 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-14FFFF 30 32 140000-147FFF	17	32	1A8000-1AFFFF
20 32 190000-197FFF 21 32 188000-18FFFF 22 32 180000-187FFF 23 32 178000-17FFFF 24 32 170000-177FFF 25 32 168000-16FFFF 26 32 160000-167FFF 27 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-14FFFF 30 32 140000-147FFF	18	32	1A0000-1A7FFF
21 32 188000-18FFFF 22 32 180000-187FFF 23 32 178000-17FFFF 24 32 170000-177FFF 25 32 168000-16FFFF 26 32 160000-167FFF 27 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-14FFFF 30 32 140000-147FFF	19	32	198000-19FFFF
22 32 180000-187FFF 23 32 178000-17FFFF 24 32 170000-177FFF 25 32 168000-16FFFF 26 32 160000-167FFF 27 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-14FFFF 30 32 140000-147FFF	20	32	190000-197FFF
23 32 178000-17FFFF 24 32 170000-177FFF 25 32 168000-16FFFF 26 32 160000-167FFF 27 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-14FFFF 30 32 140000-147FFF	21	32	188000-18FFFF
24 32 170000-177FFF 25 32 168000-16FFFF 26 32 160000-167FFF 27 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-14FFFF 30 32 140000-147FFF	22	32	180000-187FFF
25 32 168000-16FFFF 26 32 160000-167FFF 27 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-14FFFF 30 32 140000-147FFF	23	32	178000-17FFFF
26 32 160000-167FFF 27 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-14FFFF 30 32 140000-147FFF	24	32	170000-177FFF
27 32 158000-15FFFF 28 32 150000-157FFF 29 32 148000-14FFFF 30 32 140000-147FFF	25	32	168000-16FFFF
28 32 150000-157FFF 29 32 148000-14FFFF 30 32 140000-147FFF	26	32	160000-167FFF
29 32 148000-14FFFF 30 32 140000-147FFF	27	32	158000-15FFFF
30 32 140000-147FFF	28	32	150000-157FFF
	29	32	148000-14FFFF
31 32 138000-13FFFF	30	32	140000-147FFF
	31	32	138000-13FFFF

Table 24. Top Boot Block Addresses, M28W320FCT (continued)

#	Size (KWord)	Address Range
32	32	130000-137FFF
33	32	128000-12FFFF
34	32	120000-127FFF
35	32	118000-11FFFF
36	32	110000-117FFF
37	32	108000-10FFFF
38	32	100000-107FFF
39	32	0F8000-0FFFFF
40	32	0F00000-F7FFF
41	32	0E8000-0EFFFF
42	32	0E0000-0E7FFF
43	32	0D8000-0DFFFF
44	32	0D0000-0D7FFF
45	32	0C8000-0CFFFF
46	32	0C0000-0C7FFF
47	32	0B8000-0BFFFF
48	32	0B0000-0B7FFF
49	32	0A8000-0AFFFF
50	32	0A0000-0A7FFF
51	32	098000-09FFFF
52	32	090000-097FFF
53	32	088000-08FFFF
54	32	080000-087FFF
55	32	078000-07FFFF
56	32	070000-077FFF
57	32	068000-06FFFF
58	32	060000-067FFF
59	32	058000-05FFFF
60	32	050000-057FFF
61	32	048000-04FFFF
62	32	040000-047FFF
63	32	038000-03FFFF
64	32	030000-037FFF
65	32	028000-02FFFF
66	32	020000-027FFF

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Table 24. Top Boot Block Addresses, M28W320FCT (continued)

#	Size (KWord)	Address Range
67	32	018000-01FFFF
68	32	010000-017FFF
69	32	008000-00FFFF
70	32	000000h - 007FFFh

Table 25. Bottom Boot Block Addresses, M28W320FCB

#	Size (KWord)	Address Range
70	32	1F8000-1FFFFF
69	32	1F0000-1F7FFF
68	32	1E8000-1EFFFF
67	32	1E0000-1E7FFF
66	32	1D8000-1DFFFF
65	32	1D0000-1D7FFF
64	32	1C8000-1CFFFF
63	32	1C0000-1C7FFF
62	32	1B8000-1BFFFF
61	32	1B0000-1B7FFF
60	32	1A8000-1AFFFF
59	32	1A0000-1A7FFF
58	32	198000-19FFFF
57	32	190000-197FFF
56	32	188000-18FFFF
55	32	180000-187FFF
54	32	178000-17FFFF
53	32	170000-177FFF
52	32	168000-16FFFF
51	32	160000-167FFF
50	32	158000-15FFFF
49	32	150000-157FFF
48	32	148000-14FFFF
47	32	140000-147FFF
46	32	138000-13FFFF
45	32	130000-137FFF
44	32	128000-12FFFF
43	32	120000-127FFF

Table 25. Bottom Boot Block Addresses, M28W320FCB (continued)

#	Size (KWord)	Address Range
42	32	118000-11FFFF
41	32	110000-117FFF
40	32	108000-10FFFF
39	32	100000-107FFF
38	32	0F8000-0FFFFF
37	32	0F0000-0F7FFF
36	32	0E8000-0EFFFF
35	32	0E0000-0E7FFF
34	32	0D8000-0DFFFF
33	32	0D0000-0D7FFF
32	32	0C8000-0CFFFF
31	32	0C0000-0C7FFF
30	32	0B8000-0BFFFF
29	32	0B0000-0B7FFF
28	32	0A8000-0AFFFF
27	32	0A0000-0A7FFF
26	32	098000-09FFFF
25	32	090000-097FFF
24	32	088000-08FFFF
23	32	080000-087FFF
22	32	078000-07FFFF
21	32	070000-077FFF
20	32	068000-06FFFF
19	32	060000-067FFF
18	32	058000-05FFFF
17	32	050000-057FFF
16	32	048000-04FFFF
15	32	040000-047FFF
14	32	038000-03FFFF
13	32	030000-037FFF
12	32	028000-02FFFF
11	32	020000-027FFF
10	32	018000-01FFFF
9	32	010000-017FFF
8	32	008000-00FFFF

Numonyx

Table 25. Bottom Boot Block Addresses, M28W320FCB (continued)

#	Size (KWord)	Address Range
7	4	007000-007FFF
6	4	006000-006FFF
5	4	005000-005FFF
4	4	004000-004FFF
3	4	003000-003FFF
2	4	002000-002FFF
1	4	001000-001FFF
0	4	000000h - 000FFFh

Appendix B Common Flash Interface (CFI)

The Common Flash Interface is a JEDEC approved, standardized data structure that can be read from the Flash memory device. It allows a system software to query the device to determine various electrical and timing parameters, density information and functions supported by the memory. The system can interface easily with the device, enabling the software to upgrade itself when necessary.

When the CFI Query Command (RCFI) is issued the device enters CFI Query mode and the data structure is read from the memory. *Table 26*, *Table 27*, *Table 28*, *Table 29*, *Table 30* and *Table 31* show the addresses used to retrieve the data.

The CFI data structure also contains a security area where a 64 bit unique security number is written (see *Table 31: Security Code Area*). This area can be accessed only in Read mode by the final user. It is impossible to change the security number after it has been written by Numonyx. Issue a Read command to return to Read mode.

Table 26. Query Structure Overview⁽¹⁾

Offset	Sub-section Name	Description
00h	Reserved	Reserved for algorithm-specific information
10h	CFI Query Identification String	Command set ID and algorithm data offset
1Bh	System Interface Information	Device timing & voltage information
27h	Device Geometry Definition	Flash device layout
Р	Primary Algorithm-specific Extended Query table	Additional information specific to the Primary Algorithm (optional)
А	Alternate Algorithm-specific Extended Query table	Additional information specific to the Alternate Algorithm (optional)

^{1.} Query data are always presented on the lowest order data outputs.

Table 27. CFI Query Identification String⁽¹⁾

Offset	Data	Description	Value
00h	0020h	Manufacturer Code	Numonyx
01h	88BAh 88BBh	Device Code	Top Bottom
02h-0Fh	reserved	Reserved	
10h	0051h		"Q"
11h	0052h	Query Unique ASCII String "QRY"	"R"
12h	0059h		"Y"
13h	0003h	Primary Algorithm Command Set and Control Interface ID code 16 bit	Intel compatible
14h	0000h	ID code defining a specific algorithm	inter compatible
15h	0035h	Address for Primary Algorithm extended Quary table (see Table 20)	P = 35h
16h	0000h	Address for Primary Algorithm extended Query table (see <i>Table 29</i>)	F - 35H

№ numonyx 51/69

Table 27. CFI Query Identification String⁽¹⁾ (continued)

Offset	Data	Description	Value
17h	0000h	Alternate Vendor Command Set and Control Interface ID Code second	NA
18h	0000h	vendor - specified algorithm supported (0000h means none exists)	INA
19h	0000h	Address for Alternate Algorithm extended Query table	NA
1Ah	0000h	(0000h means none exists)	INA

^{1.} Query data are always presented on the lowest order data outputs (DQ7-DQ0) only. DQ8-DQ15 are '0'.

Table 28. CFI Query System Interface Information

Offset	Data	Description	Value
1Bh	0027h	V _{DD} Logic Supply Minimum Program/Erase or Write voltage bit 7 to 4BCD value in volts bit 3 to 0BCD value in 100 mV	2.7V
1Ch	0036h	V _{DD} Logic Supply Maximum Program/Erase or Write voltage bit 7 to 4BCD value in volts bit 3 to 0BCD value in 100 mV	3.6V
1Dh	00B4h	V _{PP} [Programming] Supply Minimum Program/Erase voltage bit 7 to 4HEX value in volts bit 3 to 0BCD value in 100 mV	11.4V
1Eh	00C6h	V _{PP} [Programming] Supply Maximum Program/Erase voltage bit 7 to 4HEX value in volts bit 3 to 0BCD value in 100 mV	12.6V
1Fh	0004h	Typical time-out per single word program = 2 ⁿ μs	16µs
20h	0004h	Typical time-out for Double/ Quadruple Word Program = 2 ⁿ μs	16µs
21h	000Ah	Typical time-out per individual block erase = 2 ⁿ ms	1s
22h	0000h	Typical time-out for full chip erase = 2 ⁿ ms	NA
23h	0005h	Maximum time-out for word program = 2 ⁿ times typical	512µs
24h	0005h	Maximum time-out for Double/ Quadruple Word Program = 2 ⁿ times typical	512µs
25h	0003h	Maximum time-out per individual block erase = 2 ⁿ times typical	8s
26h	0000h	Maximum time-out for chip erase = 2 ⁿ times typical	NA

Table 29. Device Geometry Definition

Table 23.		Device Geometry Definition						
	Offset Word Data		Description	Value				
	27h 0016h		Device Size = 2 ⁿ in number of bytes	4 MByte				
	28h 29h	0001h 0000h	Flash Device Interface Code description	x16 Async.				
	2Ah 2Bh	0003h 0000h	Maximum number of bytes in multi-byte program or page = 2 ⁿ	8				
2Ch 0002h		0002h	Number of Erase Block Regions within the device. It specifies the number of regions within the device containing contiguous Erase Blocks of the same size.	2				
	2Dh 2Eh	003Eh 0000h	Region 1 Information Number of identical-size erase block = 003Eh+1	63				
20FCT	2Fh 30h	0000h 0001h	Region 1 Information Block size in Region 1 = 0100h * 256 byte	64 KByte				
M28W320FCT	31h 32h	0007h 0000h	Region 2 Information Number of identical-size erase block = 0007h+1	8				
	33h 34h	0020h 0000h	Region 2 Information Block size in Region 2 = 0020h * 256 byte	8 KByte				
	2Dh 2Eh	0007h 0000h	Region 1 Information Number of identical-size erase block = 0007h+1	8				
20FCB	2Fh 30h	0020h 0000h	Region 1 Information Block size in Region 1 = 0020h * 256 byte	8 KByte				
M28W320FCB	31h 32h	003Eh 0000h	Region 2 Information Number of identical-size erase block = 003Eh=1	63				
	33h 34h	0000h 0001h	Region 2 Information Block size in Region 2 = 0100h * 256 byte	64 KByte				

Table 30. Primary Algorithm-Specific Extended Query Table

Offset P = 35h ⁽¹⁾	Data	Description	Value
(P+0)h = 35h	0050h		"P"
(P+1)h = 36h	0052h	Primary Algorithm extended Query table unique ASCII string "PRI"	"R"
(P+2)h = 37h	0049h		"]"
(P+3)h = 38h	0031h	Major version number, ASCII	"1"
(P+4)h = 39h	0030h	Minor version number, ASCII	"0"
(P+5)h = 3Ah	0066h	Extended Query table contents for Primary Algorithm. Address (P+5)h	
(P+6)h = 3Bh	0000h	contains less significant byte.	
(P+7)h = 3Ch	0000h	bit 0Chip Erase supported(1 = Yes, 0 = No) bit 1Suspend Erase supported(1 = Yes, 0 = No)	No
		bit 2Suspend Program supported(1 = Yes, 0 = No)	Yes
		bit 3Legacy Lock/Unlock supported(1 = Yes, 0 = No)	Yes
		bit 4Queued Erase supported(1 = Yes, 0 = No)	No
(D 0)b = 2Db	0000h	bit 5Instant individual block locking supported(1 = Yes, 0 = No)	No
(P+8)h = 3Dh		bit 6Protection bits supported(1 = Yes, 0 = No)	Yes
		bit 7Page mode read supported(1 = Yes, 0 = No)	Yes
		bit 8Synchronous read supported(1 = Yes, 0 = No)	No
		bit 31 to 9Reserved; undefined bits are '0'	No
(P+9)h = 3Eh	0001h	Supported Functions after Suspend Read Array, Read Status Register and CFI Query are always supported during Erase or Program operation bit 0Program supported after Erase Suspend (1 = Yes, 0 = No) bit 7 to 1Reserved; undefined bits are '0'	Yes
(P+A)h = 3Fh	0003h	Block Lock Status	
(P+B)h = 40h	0000h	Defines which bits in the Block Status Register section of the Query are implemented. Address (P+A)h contains less significant byte bit 0Block Lock Status Register Lock/Unlock bit active(1 = Yes, 0 = No) bit 1Block Lock Status Register Lock-Down bit active (1 = Yes, 0 = No) bit 15 to 2Reserved for future use; undefined bits are '0'	Yes Yes
(P+C)h = 41h	0030h	V _{DD} Logic Supply Optimum Program/Erase voltage (highest performance) bit 7 to 4HEX value in volts bit 3 to 0BCD value in 100 mV	3V
(P+D)h = 42h	00C0h	V _{PP} Supply Optimum Program/Erase voltage bit 7 to 4HEX value in volts bit 3 to 0BCD value in 100 mV	12V
(P+E)h = 43h	0001h	Number of Protection register fields in JEDEC ID space. "00h," indicates that 256 protection bytes are available	01

Table 30. Primary Algorithm-Specific Extended Query Table

Offset P = 35h ⁽¹⁾	Data	Description	Value				
(P+F)h = 44h	0080h	Protection Field 1: Protection Description	80h				
(P+10)h = 45h	0000h	This field describes user-available. One Time Programmable (OTP) Protection register bytes. Some are pre-programmed with device unique					
(P+11)h = 46h	0003h	serial numbers. Others are user programmable. Bits 0–15 point to the					
(P+12)h = 47h	0003h	serial numbers. Others are user programmable. Bits 0–15 point to the Protection register Lock byte, the section's first byte. The following bytes are factory pre-programmed and user-programmable. bit 0 to 7 Lock/bytes JEDEC-plane physical low address bit 8 to 15Lock/bytes JEDEC-plane physical high address bit 16 to 23 "n" such that 2 ⁿ = factory pre-programmed bytes bit 24 to 31 "n" such that 2 ⁿ = user programmable bytes					
(P+13)h = 48h		Reserved					

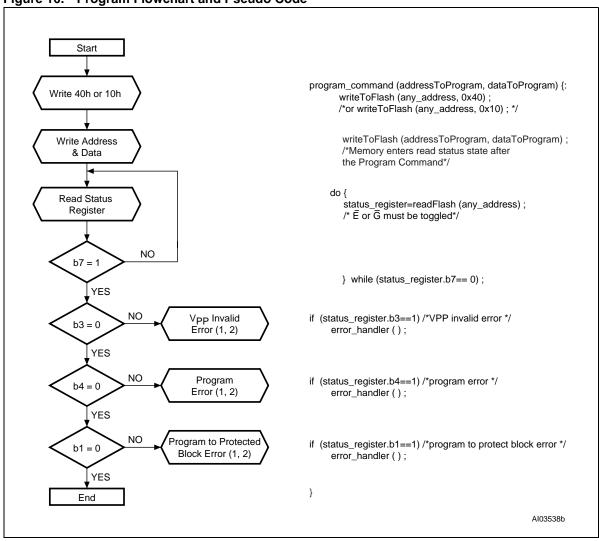
^{1.} See *Table 27*, offset 15 for P pointer definition.

Table 31. Security Code Area

Offset	Data	Description
80h	00XX	Protection Register Lock
81h	XXXX	
82h	XXXX	64 hite unique device number
83h	XXXX	64 bits: unique device number
84h	XXXX	
85h	XXXX	
86h	XXXX	
87h	XXXX	
88h	XXXX	420 hita Haar Pragrammahla OTD
89h	XXXX	– 128 bits: User Programmable OTP
8Ah	XXXX	
8Bh	XXXX	
8Ch	XXXX	

Appendix C Flowcharts and pseudo codes

Figure 16. Program Flowchart and Pseudo Code



- Status check of b1 (Protected Block), b3 (V_{PP} Invalid) and b4 (Program Error) can be made after each program operation or after a sequence.
- 2. If an error is found, the Status Register must be cleared before further Program/Erase Controller operations.

YES

YES

YES

YES

b3 = 0

b4 = 0

b1 = 0

End

NO

NO

NO

Start Write 30h double_word_program_command (addressToProgram1, dataToProgram1, addressToProgram2, dataToProgram2) writeToFlash (any_address, 0x30); Write Address 1 writeToFlash (addressToProgram1, dataToProgram1); /*see note (3) */ & Data 1 (3) writeToFlash (addressToProgram2, dataToProgram2); /*see note (3) */ /*Memory enters read status state after Write Address 2 the Program command*/ & Data 2 (3) status_register=readFlash (any_address); Read Status /* E or G must be toggled*/ Register NO b7 = 1} while (status_register.b7== 0);

if (status_register.b3==1) /*VPP invalid error */

if (status_register.b4==1) /*program error */

if (status_register.b1==1) /*program to protect block error */

error_handler();

error_handler();

error_handler();

Figure 17. Double Word Program Flowchart and Pseudo Code

 Status check of b1 (Protected Block), b3 (V_{PP} Invalid) and b4 (Program Error) can be made after each program operation or after a sequence.

}

2. If an error is found, the Status Register must be cleared before further Program/Erase operations.

V_{PP} Invalid

Error (1, 2)

Program

Error (1, 2)

Program to Protected

Block Error (1, 2)

3. Address 1 and Address 2 must be consecutive addresses differing only for bit A0.

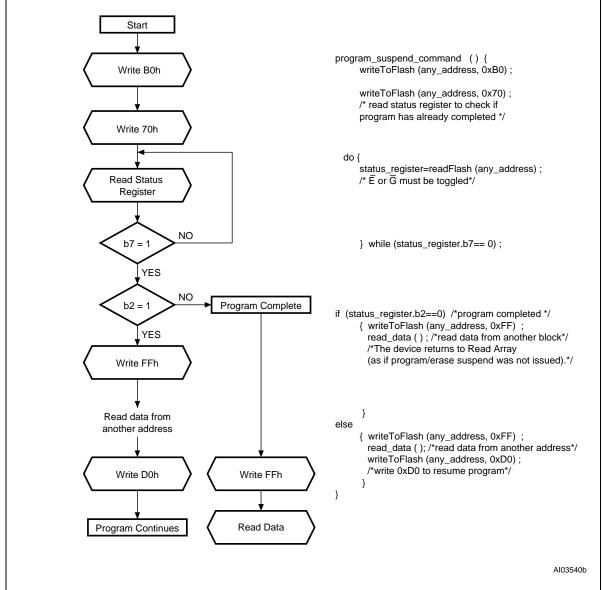
AI03539h

Start quadruple_word_program_command (addressToProgram1, dataToProgram1, Write 56h addressToProgram2, dataToProgram2, addressToProgram3, dataToProgram3, addressToProgram4, dataToProgram4) { Write Address 1 writeToFlash (any_address, 0x56); & Data 1 (3) writeToFlash (addressToProgram1, dataToProgram1); /*see note (3) */ Write Address 2 writeToFlash (addressToProgram2, dataToProgram2); & Data 2 (3) /*see note (3) */ writeToFlash (addressToProgram3, dataToProgram3); /*see note (3) */ Write Address 3 & Data 3 (3) writeToFlash (addressToProgram4, dataToProgram4); /*see note (3) */ Write Address 4 /*Memory enters read status state after & Data 4 (3) the Program command*/ do { status_register=readFlash (any_address); Read Status /* E or G must be toggled*/ Register NO b7 = 1} while (status_register.b7== 0); YES NO V_{PP} Invalid if (status_register.b3==1) /*VPP invalid error */ b3 = 0Error (1, 2) error_handler(); YES NO if (status_register.b4==1) /*program error */ Program b4 = 0error_handler(); Error (1, 2) YES NO Program to Protected if (status_register.b1==1) /*program to protect block error */ b1 = 0Block Error (1, 2) error_handler(); YES } End AI06233

Figure 18. Quadruple Word Program Flowchart and Pseudo Code

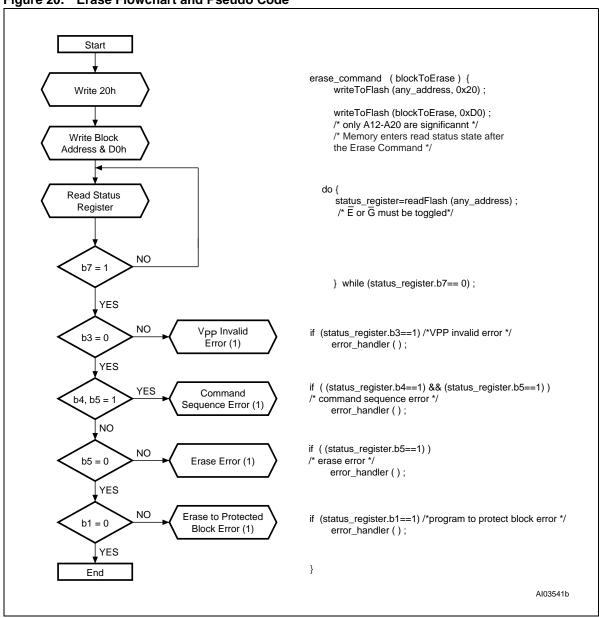
- Status check of b1 (Protected Block), b3 (V_{PP} Invalid) and b4 (Program Error) can be made after each program operation or after a sequence.
- 2. If an error is found, the Status Register must be cleared before further Program/Erase operations.
- 3. Address 1 to Address 4 must be consecutive addresses differing only for bits A0 and A1.

Figure 19. Program Suspend & Resume Flowchart and Pseudo Code Start program_suspend_command () { Write B0h



59/69 🚺 numonyx

Figure 20. Erase Flowchart and Pseudo Code

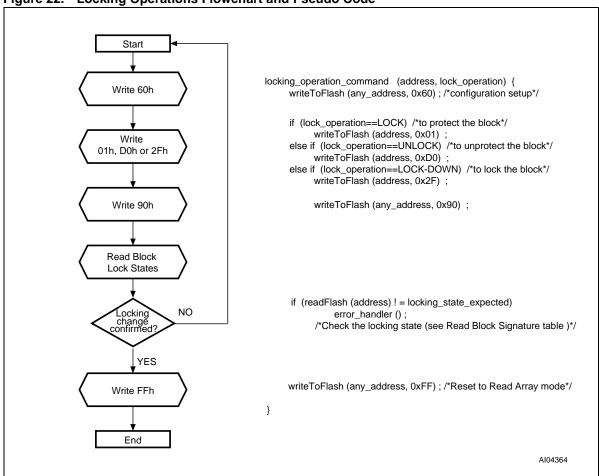


1. If an error is found, the Status Register must be cleared before further Program/Erase operations.

Start erase_suspend_command () { writeToFlash (any_address, 0xB0); Write B0h writeToFlash (any_address, 0x70); /* read status register to check if erase has already completed */ Write 70h do { Read Status status_register=readFlash (any_address); Register /* E or G must be toggled*/ NO } while (status_register.b7== 0); b7 = 1YES NO b6 = 1Erase Complete if (status_register.b6==0) /*erase completed */ { writeToFlash (any_address, 0xFF) ; ⊥YES read_data(); /*read data from another block*/ Write FFh /*The device returns to Read Array (as if program/erase suspend was not issued).*/ Read data from another block or Program/Protection Program or Block Protect/Unprotect/Lock else { writeToFlash (any_address, 0xFF) ; read_program_data (); Write D0h Write FFh /*read or program data from another address*/ writeToFlash (any_address, 0xD0); /*write 0xD0 to resume erase*/ **Erase Continues** Read Data AI03542b

Figure 21. Erase Suspend & Resume Flowchart and Pseudo Code

Figure 22. Locking Operations Flowchart and Pseudo Code



62/69 Numonyx

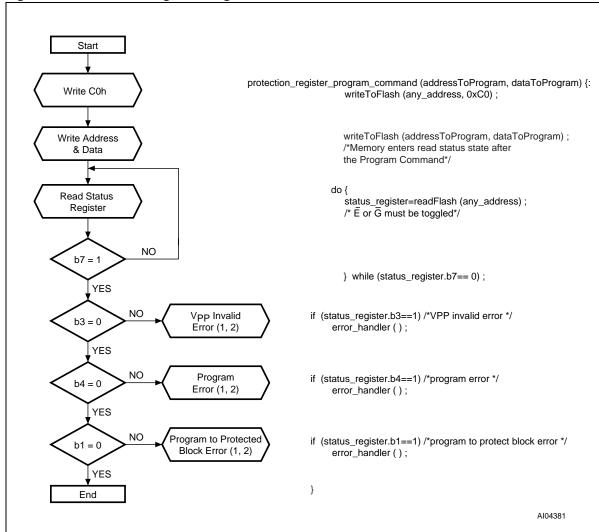


Figure 23. Protection Register Program Flowchart and Pseudo Code

- Status check of b1 (Protected Block), b3 (V_{PP} Invalid) and b4 (Program Error) can be made after each program operation or after a sequence.
- 2. If an error is found, the Status Register must be cleared before further Program/Erase Controller operations.

Appendix D Command interface and Program/Erase Controller state

Table 32. Write State Machine Current/Next, sheet 1 of 2.⁽¹⁾

	Command Input (and Next State)		State)							
Current State	SR bit 7	Data When Read	Read Array (FFh)	Program Setup (10/40h)	Erase Setup (20h)	Erase Confirm (D0h)	Prog/Ers Suspend (B0h)	Prog/Ers Resume (D0h)	Read Status (70h)	Clear Status (50h)
Read Array	"1"	Array	Read Array	Prog. Setup	Ers. Setup		Read Array		Read Sts.	Read Array
Read Status	"1"	Status	Read Array	Program Setup	Erase Setup		Read Array		Read Sts	Read Array
Read Elect.Sg.	"1"	Electronic Signature	Read Array	Program Setup	Erase Setup		Read Array		Read Sts	Read Array
Read CFI Query	"1"	CFI	Read Array	Program Setup	Erase Setup		Read Array		Read Sts	Read Array
Lock Setup	"1"	Status	Lock	Command	Error	Lock (complete)	Lock Cmd Error	Lock (complete)	Lock Com	mand Error
Lock Cmd Error	"1"	Status	Read Array	Program Setup	Erase Setup		Read Array		Read Sts	Read Array
Lock (complete)	"1"	Status	Read Array	Program Setup	Erase Setup		Read Array		Read Sts	Read Array
Prot. Prog. Setup	"1"	Status			Pı	rotection Reg	jister Progra	m		
Prot. Prog. (continue)	"0"	Status			Protec	tion Register	Program co	ontinue		
Prot. Prog. (complete)	"1"	Status	Read Array	Program Setup	Erase Setup		Read Array		Read Sts	Read Array
Prog. Setup	"1"	Status		•	•	Prog	ram		•	
Program (continue)	"0"	Status		Program	(continue)	Prog. Sus Read Sts		ogram (continue)		
Prog. Sus Status	"1"	Status	Prog. Sus Read Array	_	Suspend to Array	Program (continue)	Prog. Sus Read Array	Program (continue)	Prog. Sus Read Sts	Prog. Sus Read Array
Prog. Sus Read Array	"1"	Array	Prog. Sus Read Array		Suspend to Array	Program (continue)	Prog. Sus Read Array	Program (continue)	Prog. Sus Read Sts	Prog. Sus Read Array
Prog. Sus Read Elect.Sg.	"1"	Electronic Signature	Prog. Sus Read Array		Suspend to Array	Program (continue)	Prog. Sus Read Array	Program (continue)	Prog. Sus Read Sts	Prog. Sus Read Array
Prog. Sus Read CFI	"1"	CFI	Prog. Sus Read Array	Program Suspend to Read Array		Program (continue)	Prog. Sus Read Array	Program (continue)	Prog. Sus Read Sts	Prog. Sus Read Array
Program (complete)	"1"	Status	Read Array	Program Setup	Erase Setup		Read Array		Read Sts	Read Array

Table 32. Write State Machine Current/Next, sheet 1 of 2.⁽¹⁾ (continued)

		Duta	Command Input (and Next State)							
Current State	SR bit 7		Read Array (FFh)	Program Setup (10/40h)	Erase Setup (20h)	Erase Confirm (D0h)	Prog/Ers Suspend (B0h)	Prog/Ers Resume (D0h)	Read Status (70h)	Clear Status (50h)
Erase Setup	"1"	Status	Erase	e Command	Error	Erase (continue)	Erase CmdError	Erase (continue)	Erase C	
Erase Cmd.Error	"1"	Status	Read Array	Program Setup	Erase Setup	Read Array			Read Sts	Read Array
Erase (continue)	"0"	Status	Erase (continue) Erase Sus Read Sts Erase Sus Read Sts				Erase (continue)		e)	
Erase Sus Read Sts	"1"	Status	Erase Sus Read Array	Program Setup	Erase Sus Read Array	Erase (continue)	Erase Sus Read Array	Erase (continue)	Erase Sus Read Sts	Erase Sus Read Array
Erase Sus Read Array	"1"	Array	Erase Sus Read Array	Program Setup	Erase Sus Read Array	Erase (continue)	Erase Sus Read Array	Erase (continue)	Erase Sus Read Sts	Erase Sus Read Array
Erase Sus Read Elect.Sg.	"1"	Electronic Signature	Erase Sus Read Array	Program Setup	Erase Sus Read Array	Erase (continue)	Erase Sus Read Array	Erase (continue)	Erase Sus Read Sts	Erase Sus Read Array
Erase Sus Read CFI	"1"	CFI	Erase Sus Read Array	Program Setup	Erase Sus Read Array	Erase (continue)	Erase Sus Read Array	Erase (continue)	Erase Sus Read Sts	Erase Sus Read Array
Erase (complete)	"1"	Status	Read Array	Program Setup	Erase Setup		Read Array		Read Sts	Read Array

^{1.} Cmd = Command, Elect.Sg. = Electronic Signature, Ers = Erase, Prog. = Program, Prot = Protection, Sus = Suspend.

Table 33. Write State Machine Current/Next, sheet 2 of 2 (1)

	Command Input (and Next State)								
Current State	Read Elect.Sg. (90h)	Read CFI Query (98h)	Lock Setup (60h)	Prot. Prog. Setup (C0h)	Lock Confirm (01h)	Lock Down Confirm (2Fh)	Unlock Confirm (D0h)		
Read Array	Read Elect.Sg.	Read CFI Query	Lock Setup	Prot. Prog. Setup		Read Array			
Read Status	Read Elect.Sg.	Read CFI Query	Lock Setup	Prot. Prog. Setup		Read Array			
Read Elect.Sg.	Read Elect.Sg.	Read CFI Query	Lock Setup	Prot. Prog. Setup		Read Array			
Read CFI Query	Read Elect.Sg.	Read CFI Query	Lock Setup	Prot. Prog. Setup		Read Array			
Lock Setup		Lock Comn	nand Error			Lock (complete)			
Lock Cmd Error	Read Elect.Sg.	Read CFI Query	Lock Setup	Prot. Prog. Setup		Read Array			
Lock (complete)	Read Elect.Sg.	Read CFI Query	Lock Setup	Prot. Prog. Setup		Read Array			
Prot. Prog. Setup			Protect	ion Register Prog	gram				
Prot. Prog. (continue)			Protection R	egister Program	(continue)				
Prot. Prog. (complete)	Read Elect.Sg.	Read CFI Query	Lock Setup	Prot. Prog. Setup		Read Array			
Prog. Setup				Program					
Program (continue)			Pr	ogram (continue)					
Prog. Suspend Read Status	Prog. Suspend Read Elect.Sg.	Prog. Suspend Read CFI Query		Program Suspe	nd Read Array		Program (continue)		
Prog. Suspend Read Array	Prog. Suspend Read Elect.Sg.	Prog. Suspend Read CFI Query		Program Suspe	nd Read Array		Program (continue)		
Prog. Suspend Read Elect.Sg.	Prog. Suspend Read Elect.Sg.	Prog. Suspend Read CFI Query	Program Suspend Read Array Program (continue						
Prog. Suspend Read CFI	Prog. Suspend Read Elect.Sg.	Prog. Suspend Read CFI Query	Program Suspend Read Array Program (continue						
Program (complete)	Read Elect.Sg.	Read CFIQuery	Lock Setup Prot. Prog. Read Array						
Erase Setup			Erase Comr	mand Error			Erase (continue)		
Erase Cmd.Error	Read Elect.Sg.	Read CFI Query	Lock Setup	Prot. Prog. Setup		Read Array			

Table 33. Write State Machine Current/Next, sheet 2 of 2 (continued)⁽¹⁾

	Command Input (and Next State)								
Current State	Read Elect.Sg. (90h)	Read CFI Query (98h)	Lock Setup (60h)	Prot. Prog. Setup (C0h)	Lock Confirm (01h)	Lock Down Confirm (2Fh)	Unlock Confirm (D0h)		
Erase (continue)			E	rase (continue)					
Erase Suspend Read Ststus	Erase Suspend Read Elect.Sg.	Suspend Suspend Lock Read Read CFI		Erase Suspend Read Array		Erase (continue)			
Erase Suspend Read Array	Erase Suspend Read Elect.Sg.	Erase Suspend Read CFI Query	Lock Setup	Setup Erase Suspend Read Array		Erase (continue)			
Erase Suspend Read Elect.Sg.	Erase Suspend Read Elect.Sg.	Erase Suspend Read CFI Query	Lock Setup	Erase Suspend Read Array		Erase (continue)			
Erase Suspend Read CFI Query	Erase Suspend Read Elect.Sg.	Erase Suspend Read CFI Query	Lock Setup	Frase Suspend Read Array		Erase (continue)			
Erase (complete)	Read Elect.Sg.	Read CFI Query	Lock Setup	Prot. Prog. Setup		Read Array			

^{1.} Cmd = Command, Elect.Sg. = Electronic Signature, Prog. = Program, Prot = Protection.

11 Revision history

Table 34. Document revision history

Date	Revision	Changes
24-May-2004	0.1	First Issue
23-Aug-2004	0.2	Figure 2: TSOP Connections and Figure 3: TFBGA Connections (Top view through package).
12-Jul-2005	1.0	Datasheet status promoted to Full Datasheet. 85, 90 and 100ns speed classes removed. Temperature range 1 (0 to 70°C) removed. Leaded package options removed and ECOPACK text updated.
28-Mar-2006	2	85, 90 and 100ns access time added. Table 13: Operating and AC Measurement Conditions, Table 16: Read AC Characteristics, Table 17: Write AC Characteristics, Write Enable Controlled, Table 18: Write AC Characteristics, Chip Enable Controlled, and Table 19: Power-Up and Reset AC Characteristics updated. Table 22: Ordering Information Scheme modified.
16-Oct-2006	3	Device function updated in <i>Table 22: Ordering Information Scheme</i> to remove the 0.13µm technology.
10-Dec-2007	4	Applied Numonyx branding.
18-Nov-2008	5	Added row #70 to Table 24: Top Boot Block Addresses, M28W320FCT; added row #0 to Table 25: Bottom Boot Block Addresses, M28W320FCB. Replaced references to ECOPACK with RoHS compliant.

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